



1/3-Inch CMOS Digital Image Sensor

AR0132AT Datasheet, Rev. 9

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Features

- Superior low-light performance
- HD video (720p60)
- Linear or high dynamic range capture
- Video/Single Frame modes
- On-chip AE and statistics engine
- Parallel and serial output
- Auto black level calibration
- · Context switching
- Temperature Sensor

Applications

- · Automotive imaging
- Video surveillance
- 720p60 video applications
- High dynamic range imaging

General Description

ON Semiconductor's AR0132AT is a 1/3-inch CMOS digital image sensor with an active-pixel array of 1280H x 960V. It captures images in either linear or high dynamic range modes, with a rolling-shutter readout. It includes sophisticated camera functions such as auto exposure control, windowing, and both video and single frame modes. It is designed for both low light and high dynamic range scene performance. It is programmable through a simple two-wire serial interface. The AR0132AT produces extraordinarily clear, sharp digital pictures, and its ability to capture both continuous video and single frames makes it the perfect choice for a wide range of applications, including surveillance and HD video.

Table 1: Key Parameters

Parameter	•	Typical Value	
Optical for	mat	1/3-inch (6 mm)	
Active pixe	els	1280 x 960 = 1.2 Mp	
Pixel size		3.75 μm	
Color filter	array	RGB Bayer, or monochrome	
Shutter ty	ре	Electronic rolling shutter	
Input clock	c range	6 – 50 MHz	
Output clo	ck maximum	74.25 MHz	
Output	Serial	HiSPi 12-, 14-, or 20-bit	
	Parallel	12-bit	
Frame	Full resolution	45 fps	
rate	720p	60 fps	
Responsivi	ity	5.48 V/lux-sec	
SNR _{MAX}		43.9 dB	
Maximum	dynamic range	>115 dB	
Supply	1/0	1.8 or 2.8 V*	
voltage	Digital	1.8 V	
	Analog	2.8 V	
	HiSPi	0.4V or 1.8V	
Power con	sumption	270 mW (1280 x 720 60 fps	
(typical)		Parallel output Linear Mode)	
		460 mW (1280x720 60 fps	
		Parallel output HDR Mode)	
Operating	temperature	-40°C to + 105° C (ambient)	
		-40°C to + 120° C (junction)	
Package o	ptions	9x9 mm iBGA	
		Bare die	

Note: *1.8V VDD_IO is recommended for better row noise performance



Ordering Information

Table 2: Available Part Numbers

Part Number	Product Description	Orderable Product Attribute Description
AR0132AT6C00XPEA0-DPBR1	RGB, 0deg CRA, iBGA Package	Drypack, Protective Film, Anti-Reflective Glass
AR0132AT6C00XPEA0-DRBR1	RGB, 0deg CRA, iBGA Package	Drypack, Anti-Reflective Glass
AR0132AT6C00XPEA0-TPBR	RGB, Odeg CRA, iBGA Package	Tape & Reel, Protective Film, Anti-Reflective Glass
AR0132AT6C00XPEA0-TRBR	RGB, Odeg CRA, iBGA Package	Tape & Reel, Anti-Reflective Glass
AR0132AT6C00XPD20	RGB, Odeg CRA, Reconstruct Die	
AR0132AT6C00XPW90	RGB, Odeg CRA, Wafer	
AR0132AT6B00XPEA0-DRBR1	RCCB, Odeg CRA, iBGA Package	Drypack, Anti-Reflective Glass
AR0132AT6B00XPW90	RCCB, Odeg CRA, Wafer	
AR0132AT6G00XPEA0-DPBR1	RGBC, 0deg CRA, iBGA Package	Drypack, Protective Film, Anti-Reflective Glass
AR0132AT6G00XPEA0-DRBR1	RGBC, 0deg CRA, iBGA Package	Drypack, Anti-Reflective Glass
AR0132AT6G00XPEA0-TPBR	RGBC, 0deg CRA, iBGA Package	Tape & Reel, Protective Film, Anti-Reflective Glass
AR0132AT6G00XPEA0-TRBR	RGBC, 0deg CRA, iBGA Package	Tape & Reel, Anti-Reflective Glass
AR0132AT6M00XPEA0-DPBR1	Mono, Odeg CRA, iBGA Package	Drypack, Protective Film, Anti-Reflective Glass
AR0132AT6M00XPEA0-DRBR1	Mono, Odeg CRA, iBGA Package	Drypack, Anti-Reflective Glass
AR0132AT6M00XPEA0-TPBR	Mono, Odeg CRA, iBGA Package	Tape & Reel, Protective Film, Anti-Reflective Glass
AR0132AT6M00XPW90	Mono, Odeg CRA, Wafer	
AR0132AT6R00XPEA0-DPBR1	RCCC, Odeg CRA, iBGA Package	Drypack, Protective Film, Anti-Reflective Glass
AR0132AT6R00XPEA0-DRBR1	RCCC, Odeg CRA, iBGA Package	Drypack, Anti-Reflective Glass
AR0132AT6R00XPEA0-TPBR	RCCC, Odeg CRA, iBGA Package	Tape & Reel, Protective Film, Anti-Reflective Glass
AR0132AT6R00XPEA0-TRBR	RCCC, Odeg CRA, iBGA Package	Tape & Reel, Anti-Reflective Glass
AR0132AT6R00XPW90	RCCC, Odeg CRA, Wafer	
AR0132AT6C00XPEAD3-GEVK	RGB Demo Kit, Sunex DSL945D	
AR0132AT6C00XPEAH3-GEVB	RGB Headboard, Sunex DSL945D	
AR0132AT6C00XPEAD3-S215-GEVK	RGB Demo Kit, Sunex DSL215	
AR0132AT6C00XPEAH3-S215-GEVB	RGB Headboard, Sunex DSL215	
AR0132AT6B00XPEAD3-GEVK	RCCB Demo Kit, Sunex DSL945D	
AR0132AT6B00XPEAH3-GEVB	RCCB Headboard, Sunex DSL945D	
AR0132AT6G00XPEAD3-GEVK	RGBC Demo Kit, Sunex DSL945D	
AR0132AT6G00XPEAH3-GEVB	RGBC Headboard, Sunex DSL945D	
AR0132AT6M00XPEAD3-GEVK	Mono Demo Kit, Sunex DSL945D	
AR0132AT6M00XPEAH3-GEVB	Mono Headboard, Sunex DSL945D	
AR0132AT6R00XPEAD3-GEVK	RCCC Demo Kit, Sunex DSL945D	
AR0132AT6R00XPEAH3-GEVB	RCCC Headboard, Sunex DSL945D	

See the ON Semiconductor Device Nomenclature document (TND310/D) for a full description of the naming convention used for image sensors. For reference documentation, including information on evaluation kits, please visit our web site at www.onsemi.com.



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General Description

The ON Semiconductor AR0132AT can be operated in its default mode or programmed for frame size, exposure, gain, and other parameters. The default mode output is a 960p-resolution image at 45 frames per second (fps). In linear mode, it outputs 12-bit raw data, using either the parallel or serial (HiSPi) output ports. In high dynamic range mode, it outputs 12-bit compressed data using parallel output, or 12-bit or 14-bit compressed or 20-bit linearized data using the HiSPi port. The device may be operated in video (master) mode or in single frame trigger mode.

FRAME_VALID and LINE_VALID signals are output on dedicated pins, along with a synchronized pixel clock in parallel mode.

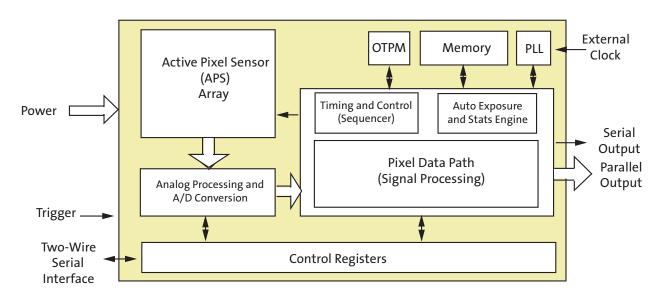
The AR0132AT includes additional features to allow application-specific tuning: windowing and offset, adjustable auto-exposure control, auto black level correction, and on-board temperature sensor. Optional register information and histogram statistic information can be embedded in first and last two lines of the image frame.

The sensor is designed to operate in a wide temperature range (-40°C to +105°C).

Functional Overview

The AR0132AT is a progressive-scan sensor that generates a stream of pixel data at a constant frame rate. It uses an on-chip, phase-locked loop (PLL) that can be optionally enabled to generate all internal clocks from a single master input clock running between 6 and 50 MHz. The maximum output pixel rate is 74.25 Mp/s, corresponding to a clock rate of 74.25 MHz. Figure 1 shows a block diagram of the sensor.

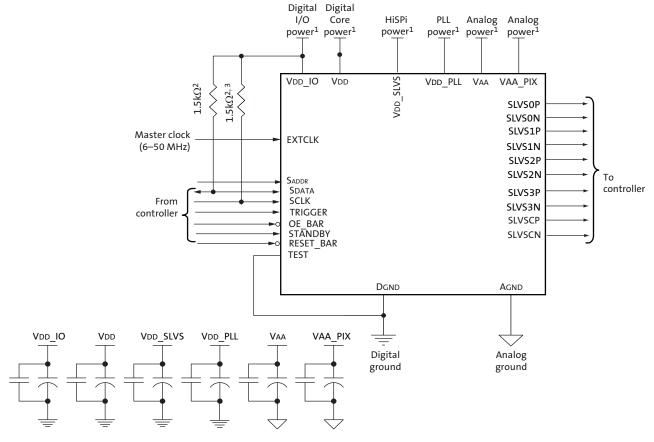
Figure 1: Block Diagram



User interaction with the sensor is through the two-wire serial bus, which communicates with the array control, analog signal chain, and digital signal chain. The core of the sensor is a 1.2 Mp Active-Pixel Sensor array. The timing and control circuitry sequences through the rows of the array, resetting and then reading each row in turn. In the time interval between resetting a row and reading that row, the pixels in the row integrate incident light. The exposure is controlled by varying the time interval between reset and

readout. Once a row has been read, the data from the columns is sequenced through an analog signal chain (providing offset correction and gain), and then through an analog-to-digital converter (ADC). The output from the ADC is a 12-bit value for each pixel in the array. The ADC output passes through a digital processing signal chain (which provides further data path corrections and applies digital gain). The sensor also offers a high dynamic range mode of operation where multiple images are combined on-chip to produce a single image at 20-bit per pixel value. A compressing mode is further offered to allow this 20-bit pixel value to be transmitted to the host system as a 12- or 14-bit value with close to zero loss in image quality. The pixel data are output at a rate of up to 74.25 Mp/s, in parallel to frame and line synchronization signals.

Figure 2: Typical Configuration: Serial Four-Lane HiSPi Interface

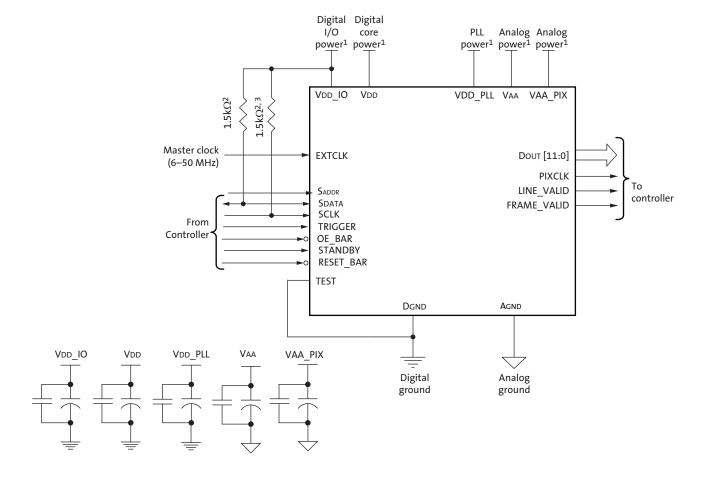


Notes:

- 1. All power supplies must be adequately decoupled.
- 2. ON Semiconductor recommends a resistor value of 1.5k Ω , but a greater value may be used for slower two-wire speed.
- 3. This pull-up resistor is not required if the controller drives a valid logic level on SCLK at all times.
- 4. The parallel interface output pads can be left unconnected if the serial output interface is used.
- 5. ON Semiconductor recommends that $0.1\mu F$ and $10\mu F$ decoupling capacitors for each power supply are mounted as close as possible to the pad. Actual values and results may vary depending on layout and design considerations. Check the AR0132AT demo headboard schematics for circuit recommendations.
- 6. ON Semiconductor recommends that analog power planes are placed in a manner such that coupling with the digital power planes is minimized.
- 7. I/O signals voltage must be configured to match VDD_IO voltage to minimize any leakage currents.



Figure 3: Typical Configuration: Parallel Pixel Data Interface



Notes:

- 1. All power supplies must be adequately decoupled.
- 2. ON Semiconductor recommends a resistor value of 1.5k Ω , but a greater value may be used for slower two-wire speed.
- 3. This pull-up resistor is not required if the controller drives a valid logic level on SCLK at all times.
- 4. The serial interface output pads and VDDSLVS can be left unconnected if the parallel output interface is used.
- 5. ON Semiconductor recommends that $0.1\mu F$ and $10\mu F$ decoupling capacitors for each power supply are mounted as close as possible to the pad. Actual values and results may vary depending on layout and design considerations. Check the AR0132AT demo headboard schematics for circuit recommendations.
- 6. ON Semiconductor recommends that analog power planes are placed in a manner such that coupling with the digital power planes is minimized.
- 7. I/O signals voltage must be configured to match VDD_IO voltage to minimize any leakage currents.

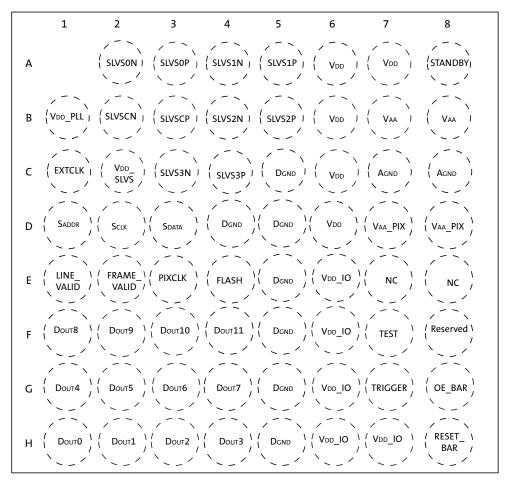




Table 3: Pin Descriptions, 9 x 9 mm, 63-ball iBGA

iBGA Pin	Туре	Description
A2	Output	HiSPi serial data, lane 0, differential N.
A3	Output	HiSPi serial data, lane 0, differential P.
A4	Output	HiSPi serial data, lane 1, differential N.
A5	Output	HiSPi serial data, lane 1, differential P.
A8	Input	Standby-mode enable pin (active HIGH).
B1	Power	PLL power.
B2	Output	HiSPi serial DDR clock differential N.
B3	Output	HiSPi serial DDR clock differential P.
B4	Output	HiSPi serial data, lane 2, differential N.
B5	Output	HiSPi serial data, lane 2, differential P.
B7, B8	Power	Analog power.
C1	Input	External input clock.
C2	Power	HiSPi power.
C3	Output	HiSPi serial data, lane 3, differential N.
C4	Output	HiSPi serial data, lane 3, differential P.
C5, D4, D5, E5, F5, G5, H5	Power	Digital ground.
A6, A7, B6, C6, D6	Power	Digital power.
C7, C8	Power	Analog ground.
D1	Input	Two-Wire Serial address select.
D2	Input	Two-Wire Serial clock input.
D3	I/O	Two-Wire Serial data I/O.
D7, D8	Power	Pixel power.
E1	Output	Asserted when Dout line data is valid.
E2	Output	Asserted when Do∪T frame data is valid.
E3	Output	Pixel clock out. Dou⊤ is valid on rising edge of this clock.
E6, F6, G6, H6, H7	Power	I/O supply power.
F1	Output	Parallel pixel data output.
F2	Output	Parallel pixel data output.
F3	Output	Parallel pixel data output.
F4	Output	Parallel pixel data output (MSB)
F7	Input.	Manufacturing test enable pin (connect to DGND).
G1	Output	Parallel pixel data output.
G2	Output	Parallel pixel data output.
G3	Output	Parallel pixel data output.
G4	Output	Parallel pixel data output.
G7	Input	Exposure synchronization input.
G8	Input	Output enable (active LOW).
H1	Output	Parallel pixel data output (LSB)
H2	Output	Parallel pixel data output.
H3	Output	Parallel pixel data output.
H4	Output	Parallel pixel data output.
H8	Input	Asynchronous reset (active LOW). All settings are restored to factory default.
E4	Output	Flash control output.
E7, E8	,P ***	No connection.
	A2 A3 A4 A4 A5 A8 B1 B2 B3 B3 B4 B5 B7, B8 C1 C2 C3 C4 C5, D4, D5, E5, F5, G5, H5 A6, A7, B6, C6, D6 C7, C8 D1 D2 D3 D7, D8 E1 E2 E3 E6, F6, G6, H6, H7 F1 F2 F3 F3 F4 F7 G1 G1 G2 G3 G4 G7 G8 H1 H2 H2 H3 H4 H8	A2 Output A3 Output A4 Output A5 Output A8 Input B1 Power B2 Output B3 Output B5 Output B7, B8 Power C1 Input C2 Power C3 Output C4 Output C5, D4, D5, E5, F5, G5, H5 Power A6, A7, B6, C6, D6 Power D1 Input D2 Input D3 I/O D7, D8 Power E1 Output E2 Output E3 Output E6, F6, G6, H6, H7 Power F1 Output F2 Output F3 Output F4 Output F7 Input G1 Output G2 Output F7 Input G1 Output G3 Output F7 Input G1 Output G3 Output G4 Output G5 Output G5 Output G6 Output G7 Input G9 Output H1 Output H2 Output H3 Output H4 Output H4 Output H8 Input

Figure 4: 9 x 9 mm 63-Ball IBGA Package



Top View (Ball Down)

Note: No ball on A1 pin, 63 balls in total in actual iBGA package.



Pixel Data Format

Pixel Array Structure

The AR0132AT pixel array is configured as 1412 columns by 1028 rows, (see Figure 5). The dark pixels are optically black and are used internally to monitor black level. Of the right 96 columns, 64 are dark pixels used for row noise correction. Of the top 24 rows of pixels, 12 of the dark rows are used for black level correction. There are 1288 columns by 972 rows of optically active pixels that can be readable. While the sensor's format is 1280 x 960, the additional active columns and active rows are included for use when horizontal or vertical mirrored readout is enabled, to allow readout to start on the same pixel. The pixel adjustment is always performed for monochrome or color versions. The active area is surrounded with optically transparent dummy pixels to improve image uniformity within the active area. Not all dummy pixels or barrier pixels can be read out.

Figure 5: Pixel Array Description

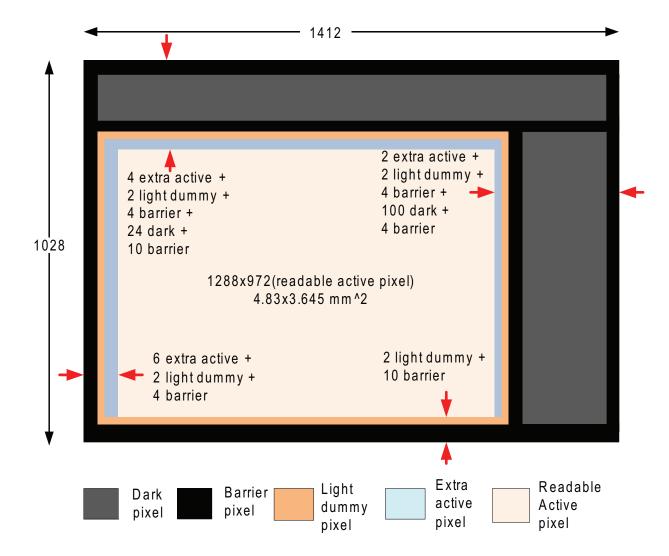
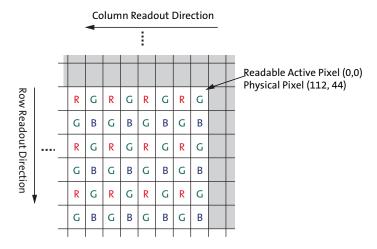




Figure 6: Pixel Color Pattern Detail (Top Right Corner)



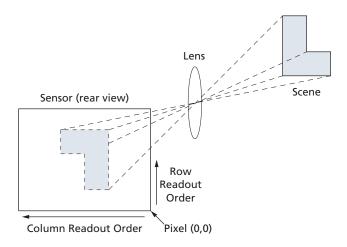
Default Readout Order

By convention, the sensor core pixel array is shown with pixel (0,0) in the top right 2corner (see Figure 6). This reflects the actual layout of the array on the die. Also, the first readable pixel location of the sensor in default condition is that of physical pixel address(112, 44). This first readable pixel location corresponds to the register $x_addr_start(R0x3004)=0x0000$ and the register $y_addr_start(R0x3002)=0x0000$.

The optical center of the readable pixel array is the location of the register $x_addr_end(R0x3008)=643$ and the register $y_addr_end(R0x3006)=485$.

When the sensor is imaging, the active surface of the sensor faces the scene as shown in Figure 7. When the image is read out of the sensor, it is read one row at a time, with the rows and columns sequenced as shown in Figure 7 on page 10.

Figure 7: Imaging a Scene





Digital Gain Control

AR0132AT supports four digital gains for the color channels: Red, Green1 (green pixels on the red rows), Green2 (green pixels on the blue rows), and Blue. Digital gain control of the AR0132AT is dependent on the configuration of the x_addr_start register. Table 4 illustrates how the digital gains are applied when x_addr_start is even or odd number.

Table 4: Digital Gain Control for odd and even x_addr_start (R0x3004)

Pixels	x_addr_start	Gain	Register
Red	Even	red_gain	R0x305A
	Odd	green1_gain	R0x3056
Green1 (on Red rows)	Even	green1_gain	R0x3056
	Odd	red_gain	R0x305A
Green2 (on Blue rows)	Even	green2_gain	R0x305C
	Odd	blue_gain	R0x3058
Blue	Even	blue_gain	R0x3058
	Odd	green2_gain	R0x305C



Output Data Format

The AR0132AT image data is read out in a progressive scan. Valid image data is surrounded by horizontal and vertical blanking (see Figure 8). The amount of horizontal row time (in clocks) is programmable through R0x300C. The amount of vertical frame time (in rows) is programmable through R0x300A. LINE_VALID (LV) is HIGH during the shaded region of Figure 8. Optional Embedded Register setup information and Histogram statistics information are available in first two and last row of image data.

Figure 8: Spatial Illustration of Image Readout

P _{0,0} P _{0,1} P _{0,2}	00 00 0000 00 00 00 00 00 00 00 0
VALID IMAGE	HORIZONTAL BLANKING
P _{m-1,0} P _{m-1,1}	00 00 00
00 00 0000 00 00	00 00 00 00 00 00
00 00 00 00 00 00	00 00 00 00 00 00
VERTICAL BLANKING	VERTICAL/HORIZONTAL BLANKING
00 00 0000 00 00	00 00 00 00 00 00
00 00 0000 00 00	00 00 00 00 00 00

Readout Sequence

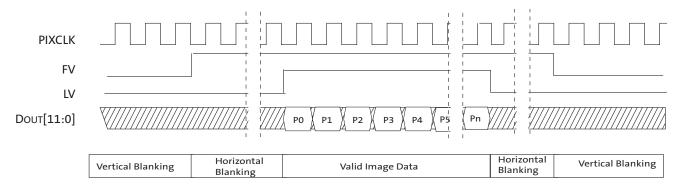
Typically, the readout window is set to a region including only active pixels. The user has the option of reading out dark regions of the array, but if this is done, consideration must be given to how the sensor reads the dark regions for its own purposes.



Parallel Output Data Timing

The output images are divided into frames, which are further divided into lines. By default, the sensor produces 968 rows of 1284 columns each. The FRAME_VALID (FV) and LINE_VALID (LV) signals indicate the boundaries between frames and lines, respectively. PIXCLK can be used as a clock to latch the data. For each PIXCLK cycle, with respect to the falling edge, one 12-bit pixel datum outputs on the DOUT pins. When both FV and LV are asserted, the pixel is valid. PIXCLK cycles that occur when FV is deasserted are called vertical blanking. PIXCLK cycles that occur when only LV is deasserted are called horizontal blanking.

Figure 9: Default Pixel Output Timing



LV and FV

The timing of the FV and LV outputs is closely related to the row time and the frame time.

FV will be asserted for an integral number of row times, which will normally be equal to the height of the output image.

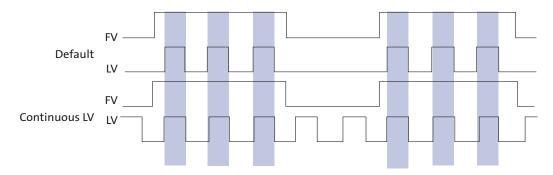
LV will be asserted during the valid pixels of each row. The leading edge of LV will be offset from the leading edge of FV by six PIXCLKs. Normally, LV will only be asserted if FV is asserted; this is configurable as described below.

LV Format Options

The default situation is for LV to be de-asserted when FV is de-asserted. By configuring R0x306E[1:0], the LV signal can take two different output formats. The formats for reading out four lines and two vertical blanking lines are shown in Figure 10.



Figure 10: LV Format Options

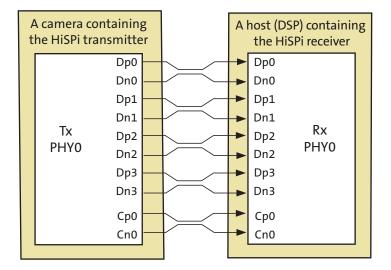


The timing of an entire frame is shown in Figure 16: "Line Timing and FRAME_VALID/LINE_VALID Signals," on page 17.

Serial Output Data Timing

The AR0132AT also uses ON Semiconductor's High-Speed Serial Pixel Interface ("HiSPi"). The physical interface comprises differential serial data lines and a differential clock line. The protocol layer formats the data and synchronization signals separately, with Sync codes defined for active image boundaries. Figure 11 shows the configuration between the HiSPi transmitter and the receiver. There are two options for HiSPi output: SLVS or HiVCM mode selectable through register 0x306E bit 9. Setting this bit to 0 selects SLVS; setting the bit to 1 selects HiVCM.

Figure 11: HiSPi Transmitter and Receiver Interface Block Diagram

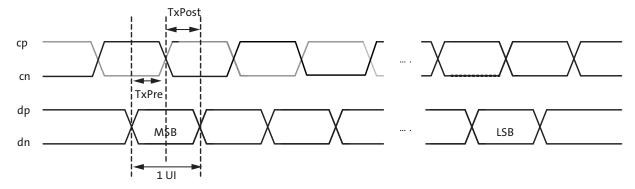




HiSPi Physical Layer

The HiSPi physical layer has four data lanes and an associated clock lane. Depending on the sensor operating mode and data rate, it can be configured to use either 2, 3, or 4 lanes. The PHY will serialize a 12- to 20-bit data word and transmit each bit of data centered on a rising edge of the clock, the second on the following falling edge of clock. Figure 12 shows bit transmission. In this example, the word is transmitted in order of MSB to LSB. The receiver latches data at the rising and falling edge of the clock.

Figure 12: Timing Diagram



DLL Timing Adjustment

The AR0132AT includes a DLL to compensate for differences in group delay for each data lane. The DLL is connected to the clock lane and each data lane, which acts as a control master for the output delay buffers. Once the DLL has gained phase lock, each lane can be delayed in 1/8 unit interval (UI) steps. This additional delay allows the user to increase the setup or hold time at the receiver circuits and can be used to compensate for skew introduced in PCB design.

Delay compensation may be set for clock and/or data lines in the hispi_timing register R0x31C0. If the DLL timing adjustment is not required, the data and clock lane delay settings should be set to a default code of 0x000 to reduce jitter, skew, and power dissipation.

Figure 13: Block Diagram of DLL Timing Adjustment

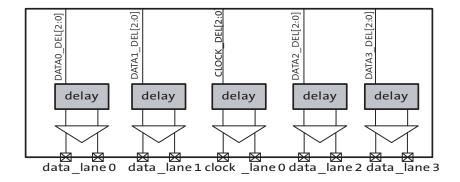


Figure 14: Delaying the Clock with Respect to Data

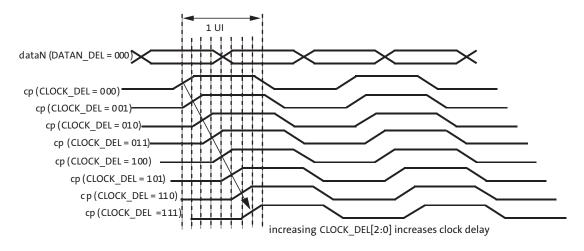
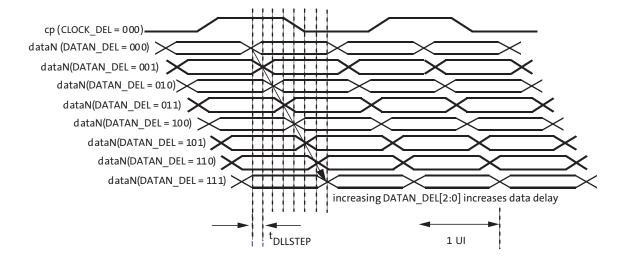


Figure 15: Delaying Data with Respect to the Clock



HiSPi Protocol Layer

The HiSPi protocol is described the HiSPi Protocol Specification document. Contact your local Field Applications Engineer or sales representative to get a copy.



Frame Time

The pixel clock (PIXCLK) represents the time needed to sample 1 pixel from the array. The sensor outputs data at the maximum rate of 1 pixel per PIXCLK. One row time (t_{ROW}) is the period from the first pixel output in a row to the first pixel output in the next row. The row time and frame time are defined by equations in Table 5.

Figure 16: Line Timing and FRAME VALID/LINE VALID Signals

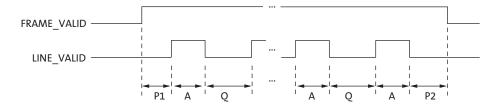


Table 5: Frame Time (Example Based on 1280 x 960, 45 Frames Per Second)

Parameter	Name	Equation	Default Timing at 74.25 MHz
А	Active data time	Context A: R0x3008 - R0x3004 + 1 Context B: R0x308E - R0x308A + 1	1280 pixel clocks = 17.23µs
P1	Frame start blanking	6 (fixed)	6 pixel clocks = 0.08μs
P2	Frame end blanking	6 (fixed)	6 pixel clocks = 0.08μs
Q	Horizontal blanking	R0x300C - A	370 pixel clocks = 4.98μs
A+Q (t _{ROW})	Line (Row) time	R0x300C	1650 pixel clocks = 22.22μs
V	Vertical blanking	Context A: (R0x300A-(R0x3006-R0x3002+1)) x (A + Q) Context B: ((R0x30AA-(R0x3090-R0x308C+1)) x (A + Q)	49,500 pixel clocks = 666.66μs
Nrows x (A + Q)	Frame valid time	Context A: ((R0x3006-R0x3002+1)*(A+Q))-Q+P1+P2 Context B: ((R0x3090-R0x308C+1)*(A+Q))-Q+P1+P2	1,584,000 pixel clocks = 21.33ms
F	Total frame time	V + (N rows x (A + Q))	1,633,500 pixel clocks = 22.22ms

Sensor timing is shown in terms of pixel clock cycles (see Figure 8 on page 12). The recommended pixel clock frequency is 74.25 MHz. The vertical blanking and the total frame time equations assume that the integration time (coarse integration time plus fine integration time) is less than the number of active lines plus the blanking lines:

If this is not the case, the number of integration lines must be used instead to determine the frame time, (see Table 6). In this example, it is assumed that the coarse integration time control is programmed with 2000 rows and the fine integration time total is zero.

For master mode, if the integration time registers exceed the total readout time, then the vertical blanking time is internally extended automatically to adjust for the additional integration time required. This extended value is **not** written back to the frame_length_lines register. The frame_length_lines register can be used to adjust frame-to-frame readout time. This register does not affect the exposure time but it may extend the readout time.



Table 6: Frame Time: Long Integration Time

Parameter			Default Timing at 74.25 MHz
F'	` `	Context A: (R0x3012 x (A + Q)) + R0x3014 + P1 + P2 Context B: (R0x3016 x (A + Q)) + V R0x3018 + P1 + P2	3,300,012 pixel clocks = 44.44ms

Note:

The AR0132AT uses column parallel analog-digital converters; thus short line timing is not possible. The minimum total line time is 1650 columns (horizontal width + horizontal blanking). The minimum horizontal blanking is 370.

Exposure

Total integration time is the result of Coarse_Integration_Time and Fine_Integration_-Time registers in Linear mode and is the result of Coarse_Integration_Time in HDR mode, and it depends also on whether manual or automatic exposure is selected.

The actual total integration time, t_{INT} is defined as:

$$tINT = tINTCoarse - 410 - tINTFine$$
 (EQ 2)

= (number_of_lines_of_integration x line_time) - ((410 + number_of_pixels_of_integration) x pixel_time)

where:

- Number of Lines of Integration (Auto Exposure Control: Enabled)
 When automatic exposure control (AEC) is enabled, the number of lines of integration may vary from frame to frame, with the limits controlled by R0x311E (minimum auto exposure time) and R0x311C (maximum auto exposure time).
- Number of Lines of Integration (Auto Exposure Control: Disabled)
 If AEC is disabled, the number of lines of integration equals the value in R0x3012 (context A) or R0x3016 (context B).
- Number of Pixels of Integration
 The number of fine integration time pixels is independent of AEC mode (enabled or disabled):
 - Context A: the number of pixels of integration equals the value in R0x3014.
 - Context B: the number of pixels of integration equals the value in R0x3018.
 - where < Fine_Integration_Time < (Line_Length_Pck 545) in linear mode.

Typically, the value of the Coarse_Integration_Time register is limited to the number of lines per frame (which includes vertical blanking lines), such that the frame rate is not affected by the integration time. For more information on coarse and fine integration time settings limits, please refer to the Register Reference document.

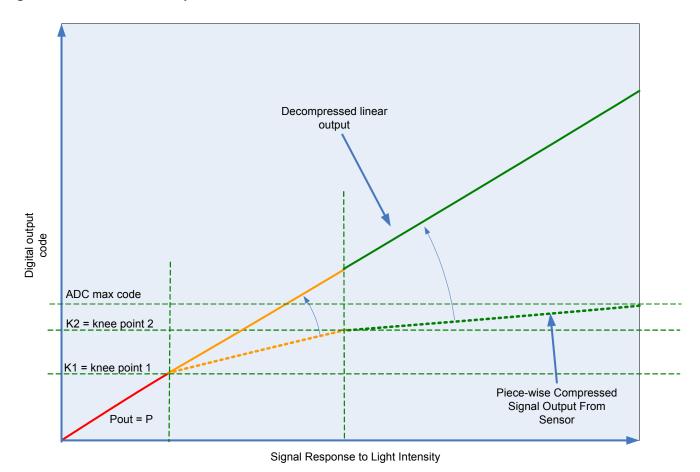
Note:

In HDR mode, there are specific limitations on coarse_integration_time due to the number of line buffers available. Please refer to the section called "HDR Specific Exposure Settings" on page 21.

High Dynamic Range Mode

By default, the sensor powers up in Linear Mode, however, the AR0132AT can be configured to run in HDR mode. The HDR scheme used is multi-exposure HDR. This allows the sensor to handle 120dB of dynamic range. The sensor also features a linear mode. In HDR mode, the sensor sequentially captures three exposures by maintaining three separate read and reset pointers that are interleaved within the rolling shutter readout. The intermediate pixel values are stored in line buffers while waiting for the three exposure values to be present. As soon as a pixel's three exposure values are available, they are combined to create a linearized 20-bit value for each pixel's response. This 20-bit value is then optionally compressed back to a 12- or 14-bit value for output. For 14-bit mode, the compressing is lossless. In 12-bit mode, there is minimal data loss. Figure 17 shows the HDR data compression:

Figure 17: HDR Data Compression



The HDR mode is selected when Operation_Mode_Ctrl, R0x3082[1:0] = 0. Further controls on exposure time limits and compressing are controlled by R0x3082[5:2] and R0x31D0. More details can be found in the AR0132AT Register Reference.

In HDR mode, when compression is used, there are two types of knee-points: (i) T1/T2 and T2/T3 capture knee-points and (ii) POUT and POUT2 compression knee-points (Figure 17). Aligning the capture knee-points on top of the compression knee-points,



can avoid code losses (SNR loss) in the compression. Table 7 and Table 8 below show the knee points for the different modes. Alternatively, the sensor automatically reports the knee points and can be read directly from registers R0x319A and R0x319C.

Table 7: Knee Points for Compression to 14 Bits

T1/T2 Exposure Ratio (R1) R0x3082[3:2]	P1	Роит 1 = P1	P2	POUT2 = (P2 - P1)/ R1 + POUT1	T2/T3 Exposure Ratio (R2) R0x3082[5:4]	Рмах	Роит _{мах} = (Рмах - Р2)/ (R1*R2) + Роит2
4x	2 ¹²	4096	2 ¹⁴	7168	4x	2 ¹⁶	10240
					8x	2 ¹⁷	10752
					16x	2 ¹⁸	11008
8x	2 ¹²	4096	2 ¹⁵	7680	4x	2 ¹⁷	10752
					8x	2 ¹⁸	11264
					16x	2 ¹⁹	11520
16x	2 ¹²	4096	2 ¹⁶	7936	4x	2 ¹⁸	11008
					8x	2 ¹⁹	11520
					16x	2 ²⁰	11776

Table 8: Knee Points for Compression to 12 Bits

T1/T2 Exposure Ratio (R1) R0x3082[3:2]	P1	Роит 1 = P1	P2	POUT2 = (P2 - P1)/ (R1* 4)+ POUT1	T2/T3 Exposure Ratio (R2) R0x3082[5:4]	PMAX	POUT _{MAX} = (PMAX - P2)/ (R1*R2*4) + POUT2
4x	2 ¹¹	2048	2 ¹⁴	2944	4x	2 ¹⁶	3712
					8x	2 ¹⁷	3840
					16x	2 ¹⁸	3904
8x	2 ¹¹	2048	2 ¹⁵	3008	4x	2 ¹⁷	3776
					8x	2 ¹⁸	3904
					16x	2 ¹⁹	3968
16x	2 ¹¹	2048	2 ¹⁶	3040	4x	2 ¹⁸	3808
					8x	2 ¹⁹	3936
					16x	2 ²⁰	4000



HDR Specific Exposure Settings

In HDR mode, pixel values are stored in line buffers while waiting for all 3 exposures to be available for final pixel data combination. There are 42 line buffers used to store intermediate T1 data. Due to this limitation, the maximum coarse integration time possible is equal to 42*T1/T2 lines.

For example, if R0x3082[3:2] = 2, the sensor is set to have T1/T2 ratio = 16x. Therefore the maximum number of integration lines is 42*16 = 672 lines. If coarse integration time is greater than this, the T2 integration time will stay at 42 lines. The sensor calculates the ratio internally, enabling the linearization to be performed. If companding is being used then relinearization would still follow the programmed ratio. For example, if the T1/T2 ratio was programmed to 16x but coarse integration was increased beyond 672 then one would still use the 16x relinearization formulas.

An additional limitation is the maximum number of exposure lines in relation to the frame_length_lines register. In Linear mode, as described on page 20, maximum coarse_integration_time = frame_length_lines - 1. However in HDR mode, since the coarse integration time register controls T1, the max coarse_integration time is frame_length_lines - 45.

Putting the two criteria listed above together, it can be summarized as follows:

maximum coarse integration time =
$$minimum(42 \times T1/T2, frame length lines - 45)$$
 (EQ 3)

In HDR mode, subline integration is not utilized. As such, fine integration time register changes will have no effect on the image.

There is also a limitation of the minimum number of exposure lines that can be used. This is summarized in the following formula:

minimum coarse_integration_time =
$$(0.5)*(T1/T2)*(T2/T3)$$
 (EQ 4)

Due to limitation on the internal floating point calculation, the exact ratio specified by the RATIO_T2_T3 (R0x3082[5:4]) may not be achievable.

Motion Compensation

In typical multi-exposure HDR systems, motion artifacts can be created when objects move during the T1, T2 or T3 integration time. When this happens, edge artifacts can potentially be visible and might look like a ghosting effect.

To correct this feature, the AR0132AT has special 2D motion compensation circuitry that detects motion artifacts and corrects the image accordingly.

There are two motion compensation options available. One using the default HDR motion compensation feature can be enabled by setting R0x318C[14] = 1. Additional parameters are available to control the extent of motion detection and correction as per the requirements of the specific application. These can be set in R0x318C–R0x3190. The other is using the DLO method of HDR combination. When using DLO, R0x318C[14] is ignored. DLO is enabled by setting R0x3190[13] = 1. Noise filtering is enabled by setting R0x3190[14] = 1. For more information, please refer to the AR0132AT Register Reference document.



Real-Time Context Switching

In the AR0132AT, the user may switch between two full register sets (listed in Table 9) by writing to a context switch change bit in R0x30B0[13]. This context switch will change all registers (no shadowing) at the frame start time and have the new values apply to the immediate next exposure and readout time.

Table 9: Real-Time Context-Switch Registers

	Register Number			
Register Description	Context A	Context B		
Y_Addr_Start	R0x3002	R0x308C		
X_Addr_Start	R0x3004	R0x308A		
Y_Addr_End	R0x3006	R0x3090		
X_Addr_End	R0x3008	R0x308E		
Coarse_Integration_Time	R0x3012	R0x3016		
Fine_Integration_Time	R0x3014	R0x3018		
Y_Odd_Inc	R0x30A6	R0x30A8		
Column Gain	R0x30B0[5:4]	R0x30B0[9:8]		
Green1_Gain (GreenR)	R0x3056	R0x30BC		
Blue_Gain	R0x3058	R0x30BE		
Red_Gain	R0x305A	R0x30C0		
Green2_Gain (GreenB)	R0x305C	R0x30C2		
Global_Gain	R0x305E	R0x30C4		
Frame_Length_Lines	R0x300A	R0x30AA		
Digital_Binning	R0x3032[1:0]	R0x3032[5:4]		
Operation_Mode_Ctrl	0x3082	0x3084		

Features

See the AR0132AT Register Reference for additional details.

Reset

The AR0132AT may be reset by using RESET_BAR (active LOW) or the reset register.

Hard Reset of Logic

The RESET_BAR pin can be connected to an external RC circuit for simplicity. The recommended RC circuit uses a $10k\Omega$ resistor and a $0.1\mu F$ capacitor. The rise time for the RC circuit is $1\mu s$ maximum.

Soft Reset of Logic

Soft reset of logic is controlled by the R0x301A Reset register. Bit 0 is used to reset the digital logic of the sensor while preserving the existing two-wire serial interface configuration. Furthermore, by asserting the soft reset, the sensor aborts the current frame it is processing and starts a new frame. This bit is a self-resetting bit and also returns to "0" during two-wire serial interface reads.



Clocks

The AR0132AT requires one clock input (EXTCLK).

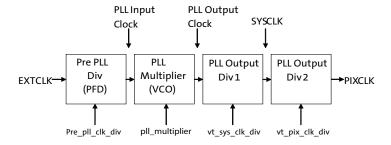
PLL-Generated Master Clock

The PLL contains a prescaler to divide the input clock applied on EXTCLK, a VCO to multiply the prescaler output, and two divider stages to generate the output clock. The clocking structure is shown in Figure 18. PLL control registers can be programmed to generate desired master clock frequency.

Note:

The PLL control registers must be programmed while the sensor is in the software Standby state. The effect of programming the PLL divisors while the sensor is in the streaming state is undefined.

Figure 18: PLL-Generated Master Clock PLL Setup



The PLL is enabled by default on the AR0132AT.

To configure and use the PLL:

- 1. Bring the AR0132AT up as normal; make sure that f_{EXTCLK} is between 6 and 50MHz and ensure the sensor is in software standby (R0x301A-B[2]= 0). PLL control registers must be set in software standby.
- 2. Set pll_multiplier, pre_pll_clk_div, vt_sys_clk_siv, and vt_pix_clk_div based on the desired input (f_{EXTCLK}) and output (f_{PIXCLK}) frequencies. Determine the M, N, P1, and P2 values to achieve the desired f_{PIXCLK} using this formula:

 f_{PIXCLK} = (f_{EXTCLK} × M) / (N × P1 x P2) where M = PLL_Multiplier N = Pre_PLL_Clk_Div P1 = Vt_Sys_Clk_Div P2 = Vt_PIX_Clk_Div

- 3. Wait 1ms to ensure that the VCO has locked.
- 4. Set R0x301A[2]=1 to enable streaming and to switch from EXTCLK to the PLL-generated clock.

Notes:

- 1. The PLL can be bypassed at any time (sensor will run directly off EXTCLK) by setting R0x30B0[14]=1. However, only the parallel data interface is supported with the PLL bypassed. The PLL is always bypassed in software standby mode. To disable the PLL, the sensor must be in standby mode (R0x301A[2] = 0)
- 2. The following restrictions apply to the PLL tuning parameters:

 $32 \le M \le 255$



 $1 \le N \le 63$

P1 = 1, 2, 4, 6, 8, 10, 12, 14, 16

 $4 \le P2 \le 16$

- 3. The VCO frequency, defined as $f_{\rm VCO} = f_{EXTCLK} \times M/N$ must be within 384-768 MHz.
- 4. When PLL_Multiplier is odd, 2 MHz \leq f_{EXTCLK} / $N \leq$ 24 MHz.
- 5. If using HiSPi output mode, use the following settings for P2 (Vt_Pix_Clk_Div).
 - 5a. If 20-bit mode (4 lanes): set P2 (R0x302A) = 5
 - 5b. If 12-/14-bit mode (3 lanes): set P2 (R0x302A) = 5
 - 5c. If 12-bit mode (2 lanes): set P2 (R0x302A) = 6
 - 5d. If 14-bit mode (2 lanes): set P2 (R0x302A) = 7

The user can utilize the Register Wizard tool accompanying DevWare to generate PLL settings given a supplied input clock and desired output frequency.

Spread-Spectrum Clocking

To facilitate improved EMI performance, the external clock input allows for spread spectrum sources, with no impact on image quality. Limits of the spread spectrum input clock are:

- 5% maximum clock modulation
- 35 KHz maximum modulation frequency
- Accepts triangle wave modulation, as well as sine or modified triangle modulations.

Stream/Standby Control

The sensor supports two standby modes: Hard Standby and Soft Standby. In both modes, external clock can be optionally disabled to further minimize power consumption. If this is done, then the "Power-Up Sequence" on page 51 must be followed.

Soft Standby

Soft Standby is a low power state that is controlled through register R0x301A[2]. Depending on the value of R0x301A[4], the sensor will go to standby after completion of the current frame readout (default behavior) or after the completion of the current row readout. When the sensor comes back from Soft Standby, previously written register settings are still maintained. Soft standby will not occur if the TRIGGER pin is held high.

A specific sequence needs to be followed to enter and exit from Soft Standby.

Entering Soft Standby:

- 1. R0x301A[12] = 1 if serial mode was used
- 2. Set R0x301A[2] = 0 and drive the TRIGGER pin LOW.
- 3. External clock can be turned off to further minimize power consumption (Optional)

Exiting Soft Standby:

- 1. Enable external clock if it was turned off
- 2. R0x301A[2] = 1 or drive the TRIGGER pin HIGH.
- 3. R0x301A[12] = 0 if serial mode is used



Hard Standby

Hard Standby puts the sensor in lower power state; previously written register settings are still maintained.

A specific sequence needs to be followed to enter and exit from Hard Standby.

Entering Hard Standby:

- 1. R0x301A[8] = 1
- 2. R0x301A[12] = 1 if serial mode was used
- 3. Assert STANDBY pin
- 4. External clock can be turned off to further minimize power consumption (Optional)

Exiting Hard Standby:

- 1. Enable external clock if it was turned off
- 2. De-assert STANDBY pin
- 3. Set R0x301A[8] = 0

Window Control

Registers x_addr_start, x_addr_end, y_addr_start, and y_addr_end control the size and starting coordinates of the image window.

The exact window height and width out of the sensor is determined by the difference between the Y address start and end registers or the X address start and end registers, respectively.

The AR0132AT allows different window sizes for context A and context B.

Blanking Control

Horizontal blank and vertical blank times are controlled by the line_length_pck and frame_length_lines registers, respectively.

- Horizontal blanking is specified in terms of pixel clocks. It is calculated by subtracting the X window size from the line_length_pck register. The minimum horizontal blanking is 370 pixel clocks.
- Vertical blanking is specified in terms of numbers of lines. It is calculated by subtracting the Y window size from the frame_length_lines register. The minimum vertical blanking is 26 lines.

The actual imager timing can be calculated using Table 5 on page 17 and Table 6 on page 18, which describe the Line Timing and FV/LV signals.

When in HDR mode, the maximum size is 1280 x 960.



Readout Modes

Digital Binning

By default, the resolution of the output image is the full width and height of the FOV as defined above. The output resolution can be reduced by digital binning. For RGB and monochrome mode, this is set by the register R0x3032. For Context A, use bits [1:0], for Context B, use bits [5:4]. Available settings are:

0b00 = No binning

0b01 = Horizontal binning

0b10 = Horizontal and vertical binning

Binning gives the advantage of reducing noise at the cost of reduced resolution. When both [horizontal and vertical binning are used, a 2x improvement in SNR is achieved, therefore improving low light performance. Binning results in a smaller resolution image, but the FOVs between binned and unbinned images are the same.

Bayer Space Resampling

All of the pixels in the FOV contribute to the output image in digital binning mode. This can result in a more pleasing output image with reduced subsampling artifacts. It also improves low-light performance. For RGB mode, resampling can be enabled by setting of register 0x306E[4] = 1.

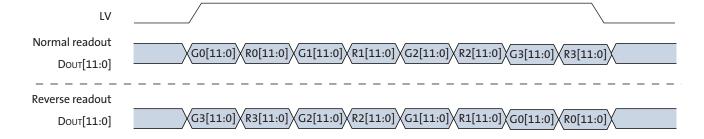
Mirror

Column Mirror Image

By setting R0x3040[14] = 1, the readout order of the columns is reversed, as shown in Figure 19. The starting Bayer color pixel is maintained in this mode by a 1-pixel shift in the imaging array.

When using horizontal mirror mode, the user must retrigger column correction. Please refer to the column correction section to see the procedure for column correction retriggering. Bayer resampling must be enabled, by setting R0x306E[4] = 1.

Figure 19: Eight Pixels in Normal and Column Mirror Readout Modes

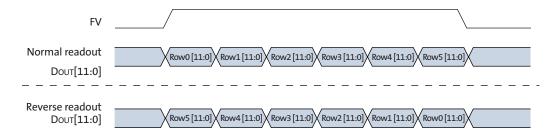




Row Mirror Image

By setting R0x3040[15] = 1, the readout order of the rows is reversed as shown in Figure 20. The starting Bayer color pixel is maintained in this mode by a 1-pixel shift in the imaging array. When using horizontal mirror mode, the user must retrigger column correction. Please refer to the column correction section to see the procedure for column correction retriggering.

Figure 20: Six Rows in Normal and Row Mirror Readout Modes



Maintaining a Constant Frame Rate

Maintaining a constant frame rate while continuing to have the ability to adjust certain parameters is the desired scenario. This is not always possible, however, because register updates are synchronized to the read pointer, and the shutter pointer for a frame is usually active during the readout of the previous frame. Therefore, any register changes that could affect the row time or the set of rows sampled causes the shutter pointer to start over at the beginning of the next frame.

By default, the following register fields cause a "bubble" in the output rate (that is, the vertical blank increases for one frame) if they are written in video mode, even if the new value would not change the resulting frame rate. The following list shows only a few examples of such registers; a full listing can be seen in the AR0132AT Register Reference.

- x_addr_start
- · x addr end
- y_addr_start
- y_addr_end
- · frame length lines
- line_length_pclk
- coarse_integration_time
- fine_integration_time
- read_mode

The size of this bubble is (Integration_Time \times t_{ROW}), calculating the row time according to the new settings.

The Coarse_Integration_Time and Fine_Integration_Time fields may be written to without causing a bubble in the output rate under certain circumstances. Because the shutter sequence for the next frame often is active during the output of the current frame, this would not be possible without special provisions in the hardware. Writes to these registers take effect two frames after the frame they are written, which allows the integration time to increase without interrupting the output or producing a corrupt frame (as long as the change in integration time does not affect the frame time).



Synchronizing Register Writes to Frame Boundaries

Changes to most register fields that affect the size or brightness of an image take effect on two frames after the one during which they are written. These fields are noted as "synchronized to frame boundaries" in the AR0132AT Register Reference. To ensure that a register update takes effect on the next frame, the write operation must be completed after the leading edge of FV and before the trailing edge of FV.

As a special case, in single frame mode, register writes that occur after FV but before the next trigger will take effect immediately on the next frame, as if there had been a Restart. However, if the trigger for the next frame occurs during FV, register writes take effect as with video mode.

Fields not identified as being frame-synchronized are updated immediately after the register write is completed. The effect of these registers on the next frame can be difficult to predict if they affect the shutter pointer.

Restart

To restart the AR0132AT at any time during the operation of the sensor, write a "1" to the Restart register (R0x301A[1] = 1). This has two effects: first, the current frame is interrupted immediately. Second, any writes to frame-synchronized registers and the shutter width registers take effect immediately, and a new frame starts (in video mode). The current row completes before the new frame is started, so the time between issuing the Restart and the beginning of the next frame can vary by about $t_{\rm ROW}$.

Image Acquisition Modes

The AR0132AT supports two image acquisition modes: video (master) and single frame.

Video

The video mode takes pictures by scanning the rows of the sensor twice. On the first scan, each row is released from reset, starting the exposure. On the second scan, the row is sampled, processed, and returned to the reset state. The exposure for any row is therefore the time between the first and second scans. Each row is exposed for the same duration, but at slightly different point in time, which can cause a shear in moving subjects as is typical with electronic rolling shutter sensors.

Single Frame

The single-frame mode operates similar to the video mode. It also scans the rows of the sensor twice, first to reset the rows and second to read the rows. Unlike video mode where a continuous stream of images are output from the image sensor, the single-frame mode outputs a single frame in response to a high state placed on the TRIGGER input pin. As long as the TRIGGER pin is held in a high state, new images will be read out. After the TRIGGER pin is returned to a low state, the image sensor will not output any new images and will wait for the next high state on the TRIGGER pin.

The TRIGGER pin state is detected during the vertical blanking period (i.e. the FV signal is low). The pin is level sensitive rather than edge sensitive. As such, image integration will only begin when the sensor detects that the TRIGGER pin has been held high for 3 consecutive clock cycles. If the trigger signal is applied to multiple sensors at the same time, the single frame output of the sensors will be synchronized to within 1 PIXCLK if is PLL disabled or 2 PIXCLKs if PLL is enabled.



During integration time of single-frame mode and video mode, the FLASH output pin is at high.

Continuous Trigger

In certain applications, multiple sensors need to have their video streams synchronized (for example, surround view or panorama view applications). The TRIGGER pin can also be used to synchronize output of multiple image sensors together and still get a video stream. This is called continuous trigger mode. Continuous trigger is enabled by holding the TRIGGER pin high. Alternatively, the TRIGGER pin can be held high until the stream bit is enabled (R0x301A[2]=1) then can be released for continuous synchronized video streaming.

If the TRIGGER pins for all connected AR0132AT sensors are connected to the same control signal, all sensors will receive the trigger pulse at the same time. If they are configured to have the same frame timing, then the usage of the TRIGGER pin guarantees that all sensors will be synchronized within 1 PIXCLK cycle if PLL is disabled, or 2 PIXCLK cycles if PLL is enabled.

With continuous trigger mode, the application can now make use of the video streaming mode while guaranteeing that all sensor outputs are synchronized. As long as the initial trigger for the sensors takes place at the same time, all subsequent video streams will be synchronous.

Temperature Sensor

The AR0132AT sensor has a built-in PTAT-based temperature sensor, accessible through registers, that is capable of measuring die junction temperature.

The temperature sensor can be enabled by writing R0x30B4[0]=1 and R0x30B4[4]=1. After this, the temperature sensor output value can be read from R0x30B2[10:0].

The value read out from the temperature sensor register is an ADC output value that needs to be converted downstream to a final temperature value in degrees Celsius. Since the PTAT device characteristic response is quite linear in the temperature range of operation required, a simple linear function in the format of listed in the equation below can be used to convert the ADC output value to the final temperature in degrees Celsius.

$$Temperature = slope \times R0x30B2[10:0] + T_0$$
 (EQ 5)

For this conversion, a minimum of 2 known points are needed to construct the line formula by identifying the slope and y-intercept " T_0 ". These calibration values can be read from registers R0x30C6 and R0x30C8 which correspond to value read at 70°C and 55°C respectively. Once read, the slope and y-intercept values can be calculated and used in the above equation.

For more information on the temperature sensor registers, refer to the AR0132AT Register Reference.



Automatic Exposure Control

The integrated automatic exposure control (AEC) is responsible for ensuring that optimal settings of exposure and gain are computed and updated every other frame. AEC can be enabled or disabled by R0x3100[0].

When AEC is disabled (R0x3100[0] = 0), the sensor uses the manual exposure value in coarse and fine shutter width registers and the manual gain value in the gain registers.

When AEC is enabled (R0x3100[0]=1), the target luma value in linear mode is set by R0x3102. For the AR0132AT this target luma has a default value of 0x0800 or about half scale. For HDR mode, the luma target maximum auto exposure value is limited by R0x311C; the minimum auto exposure is limited by R0x311E. These values are in units of line-times.

The exposure control measures current scene luminosity by accumulating a histogram of pixel values while reading out a frame. It then compares the current luminosity to the desired output luminosity. Finally, the appropriate adjustments are made to the exposure time and gain. All pixels are used, regardless of color or mono mode. In HDR mode, the coarse and fine integration time is the longest integration time of the three integration, the other two shorter integration are generated automatically base on the predefined exposure ratios.

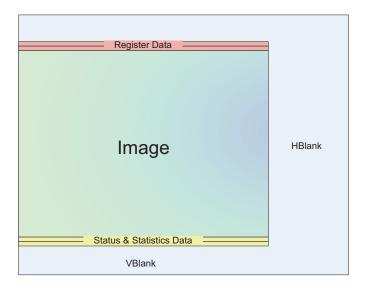
Embedded Data and Statistics

The AR0132AT has the capability to output image data and statistics embedded within the frame timing. There are two types of information embedded within the frame readout:

- 1. Embedded Data: If enabled, these are displayed on the two rows immediately before the first active pixel row is displayed.
- 2. Embedded Statistics: If enabled, these are displayed on the two rows immediately after the last active pixel row is displayed.

Note: One must have both embedded data and embedded statistics enabled or disabled together.

Figure 21: Frame Format with Embedded Data Lines Enabled





Embedded Data

The embedded data contains the configuration of the image being displayed. This includes all register settings used to capture the current frame. The registers embedded in these rows are as follows:

Line 1: Registers R0x3000 to R0x312F

Line 2: Registers R0x3136 to R0x31BF, R0x31D0 to R0x31FF

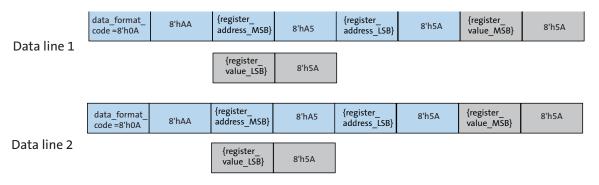
Note: All non-defined registers will have a value of 0.

In parallel mode, since the pixel word depth is 12-bits/pixel, the sensor 16-bit register data will be transferred over 2 pixels where the register data will be broken up into 8 MSB and 8 LSB. The alignment of the 8-bit data will be on the 8 MSB bits of the 12-bit pixel word. For example, of a register value of 0x1234 is to be transmitted, it will be transmitted over 2, 12-bit pixels as follows: 0x120, 0x340.

The first pixel of each line in the embedded data is a tag value of 0x0A0. This signifies that all subsequent data is 8 bit data aligned to the MSB of the 12-bit pixel.

The figure below summarizes how the embedded data transmission looks like. It should be noted that data, as shown in Figure 22, is aligned to the MSB of each word:

Figure 22: Format of Embedded Data Output within a Frame



The data embedded in these rows are as follows:

- 0x0A0 identifier
- 0xAA0
- · Register Address MSB of the first register
- 0xA50
- Register Address LSB of the first register
- 0x5A0
- Register Value MSB of the first register addressed
- 0x5A0
- Register Value LSB of the first register addressed
- 0x5A0
- Register Value MSB of the register at first address + 2
- 0x5A0
- Register Value LSB of the register at first address + 2
- 0x5A0
- etc.



Embedded Statistics

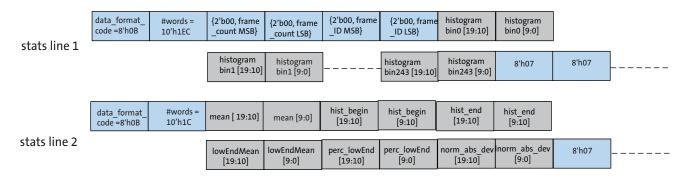
The embedded statistics contain frame identifiers and histogram information of the image in the frame. This can be used by downstream auto-exposure algorithm blocks to make decisions about exposure adjustment.

This histogram is divided into 244 bins with a bin spacing of 64 evenly spaced bins for digital code values 0 to 2^{12} , 120 evenly spaced bins for values 2^{12} to 2^{16} , 60 evenly spaced bins for values 2^{16} to 2^{20} . In HDR with a 16x exposure ratio, this approximately corresponds to the T1, T2, T3 exposures respectively.

The first pixel of each line in the embedded statistics is a tag value of 0x0B0. This signifies that all subsequent statistics data is 10 bit data aligned to the MSB of the 12-bit pixel.

The figure below summarizes how the embedded statistics transmission looks like. It should be noted that data, as shown in Figure 23, is aligned to the msb of each word:

Figure 23: Format of Embedded Statistics Output within a Frame



The statistics embedded in these rows are as follows:

Line 1:

- 0x0B0 identifier
- Register 0x303A frame_count
- Register 0x31D2 frame ID
- Histogram data histogram bins 0-243

Line 2:

- 0x0B0 (identifier)
- Mean
- · Histogram Begin
- · Histogram End
- · Low End Histogram Mean
- · Percentage of Pixels Below Low End Mean
- · Normal Absolute Deviation

Gain

Digital Gain

Digital gain can be controlled globally by R0x305E (Context A) or R0x30C4 (Context B). There are also registers that allow individual control over each Bayer color (GreenR(Green1_gain) by R0x3056, Blue_gain by R0x3058, Red_gain by R0x305A, GreenB(Green2_gain) by R0x305C).



The format for digital gain setting is *xxx.yyyyy* where 0b00100000 represents a 1x gain setting and 0b00110000 represents a 1.5x gain setting. The step size for yyyyy is 0.03125 while the step size for xxx is 1. Therefore to set a gain of 2.09375 one would set digital gain to 01000011.

Analog Gain

The AR0132AT has a column parallel architecture and therefore has an Analog gain stage per column.

There are two stages of analog gain, the first stage can be set to 1x, 2x, 4x or 8x. This is can be set in R0x30B0[5:4] (Context A) or R0x30B0[9:8] (Context B). The second stage is capable of setting an additional 0.5X, 0.75X, 1X or 1.25x gain which can be set in R0x3EE4[9:8]. 0.5X or 0.75X gain other than 1.0X or 1.25X gain will not affect device reliability but could parts to deviate from ON Semiconductor's official specification.

This allows the maximum possible analog gain to be set to 10x.

Black Level Correction

Black level correction is handled automatically by the image sensor. No adjustments are provided except to enable or disable this feature. Setting R0x30EA[15] disables the automatic black level correction. Default setting is for automatic black level calibration to be enabled.

The automatic black level correction measures the average value of pixels from a set of optically black lines in the image sensor. The pixels are averaged as if they were light-sensitive and passed through the appropriate gain. This line average is then digitally low-pass filtered over many frames to remove temporal noise and random instabilities associated with this measurement. The new filtered average is then compared to a minimum acceptable level, low threshold, and a maximum acceptable level, high threshold. If the average is lower than the minimum acceptable level, the offset correction value is increased by a predetermined amount. If it is above the maximum level, the offset correction value is decreased by a predetermined amount. The high and low thresholds have been calculated to avoid oscillation of the black level from below to above the targeted black level.

Row-wise Noise Correction

Row (Line)-wise Noise Correction is handled automatically by the image sensor. No adjustments are provided except to enable or disable this feature. Clearing R0x3044[10] disables the row noise correction. Default setting is for row noise correction to be enabled.

Row-wise noise correction is performed by calculating an average from a set of optically black pixels at the start of each line and then applying each average to all the active pixels of the line.

Column Correction

The AR0132AT uses column parallel readout architecture to achieve fast frame rate. Without any corrections, the consequence of this architecture is that different column signal paths have slightly different offsets that might show up on the final image as structured fixed pattern noise.



The AR0132AT has column correction circuitry that measures this offset and removes it from the image before output. This is done by sampling dark rows containing tied pixels and measuring an offset coefficient per column to be corrected later in the signal path.

Column correction can be enabled/disabled via R0x30D4[15]. Additionally, the number of rows used for this offset coefficient measurement is set in R0x30D4[3:0]. By default this register is set to 0x7, which means that eight rows are used. This is the recommended value. Other control features regarding column correction can be viewed in the AR0132AT Register Reference. Any changes to column correction settings need to be done when the sensor streaming is disabled and the appropriate triggering sequence must be followed as described below.

Column Correction Triggering

Column correction requires a special procedure to trigger depending on which state the sensor is in.

Column Correction Triggering on Startup

When streaming the sensor for the first time after power up, a special sequence needs to be followed to make sure that the column correction coefficients are internally calculated properly.

- 1. Follow proper power up sequence for power supplies and clocks
- 2. Apply sequencer settings if needed (Linear or HDR mode)
- 3. Apply frame timing and PLL settings as required by application
- 4. Set analog gain to 1x and low conversion gain (R0x30B0=0x1300)
- 5. Enable column correction and settings (R0x30D4=0xE007)
- 6. Disable auto re-trigger for change in conversion gain or col_gain, and enable column correction always. (R0x30BA = 0x0008).
- 7. Enable streaming (R0x301A[2] = 1) or drive the TRIGGER pin HIGH.
- 8. Wait 9 frames to settle. (First frame after coming up from standby is internally column correction disabled.)
- 9. Disable streaming (R0x301A[2] = 0)

After this, the sensor has calculated the proper column correction coefficients and the sensor is ready for streaming. Any other settings (including gain, integration time and conversion gain etc.) can be done afterwards without affecting column correction.

Column Correction Retriggering due to Mode Change

Since column offsets are sensitive to changes in the analog signal path, such changes require column correction circuitry to be retriggered for the new path. Examples of such mode changes include: horizontal mirror, vertical mirror, changes to column correction settings.

When such changes take place, the following sequence needs to take place:

- 1. Disable streaming (R0x301A[2]=0) or drive the TRIGGER pin LOW.
- 2. Enable streaming (R0x301A[2]=1) or drive the TRIGGER pin HIGH.
- 3. Wait 9 frames to settle.

Note: The above steps are not needed if the sensor is being reset (soft or hard reset) upon the mode change.



Defective Pixel Correction

Defective Pixel Correction is intended to compensate for defective pixels by replacing their value with a value based on the surrounding pixels, making the defect less noticeable to the human eye. The defect pixel correction feature supports up to 200 defects. The locations of defective pixels are stored in a table on chip during the manufacturing process; this table is accessible through the two-wire serial interface. There is no provision for later augmenting the defect table entries.

The DPC algorithm is one-dimensional, calculating the resulting averaged pixel value based on nearby pixels within a row. The algorithm distinguishes between color and monochrome parts; for color parts, the algorithm uses nearest neighbor in the same color plane.

At high gain, long exposure, and high temperature conditions, the performance of this function can degrade.

Test Patterns

The AR0132AT has the capability of injecting a number of test patterns into the top of the datapath to debug the digital logic. With one of the test patterns activated, any of the datapath functions can be enabled to exercise it in a deterministic fashion. Test patterns are selected by Test_Pattern_Mode register (R0x3070). Only one of the test patterns can be enabled at a given point in time by setting the Test_Pattern_Mode register according to Table 10. When test patterns are enabled the active area will receive the value specified by the selected test pattern and the dark pixels will receive the value in Test_Pattern_Green (R0x3074 and R0x3078) for green pixels, Test_Pattern_Blue (R0x3076) for blue pixels, and Test_Pattern_Red (R0x3072) for red pixels.

Note:

Turn off black level calibration (BLC) by setting R0x30EA[15] = 1 when Test Pattern is enabled.

Table 10: Test Pattern Modes

Test_Pattern_Mode	Test Pattern Output
0d0	No test pattern (normal operation)
0d1	Solid color test pattern
0d2	100% color bar test pattern
0d3	Fade-to-gray color bar test pattern
0d256	Walking 1s test pattern (12-bit)

Color Field

When the color field mode is selected, the value for each pixel is determined by its color. Green pixels will receive the value in Test_Pattern_Green, red pixels will receive the value in Test_Pattern_Red, and blue pixels will receive the value in Test_Pattern_Blue.

Vertical Color Bars

When the vertical color bars mode is selected, a typical color bar pattern will be sent through the digital pipeline.

Walking 1s

When the walking 1s mode is selected, a walking 1s pattern will be sent through the digital pipeline. The first value in each row is 1.



Two-Wire Serial Register Interface

The two-wire serial interface bus enables read/write access to control and status registers within the AR0132AT. The interface protocol uses a master/slave model in which a master controls one or more slave devices. The sensor acts as a slave device. The master generates a clock (SCLK) that is an input to the sensor and is used to synchronize transfers. Data is transferred between the master and the slave on a bidirectional signal (SDATA). SDATA is pulled up to VDD_IO off-chip by a $1.5 \mathrm{k}\Omega$ resistor. Either the slave or master device can drive SDATA LOW—the interface protocol determines which device is allowed to drive SDATA at any given time.

The protocols described in the two-wire serial interface specification allow the slave device to drive SCLK LOW; the AR0132AT uses SCLK as an input only and therefore never drives it LOW.

Protocol

Data transfers on the two-wire serial interface bus are performed by a sequence of low-level protocol elements:

- 1. a (repeated) start condition
- 2. a slave address/data direction byte
- 3. an (a no) acknowledge bit
- 4. a message byte
- 5. a stop condition

The bus is idle when both SCLK and SDATA are HIGH. Control of the bus is initiated with a start condition, and the bus is released with a stop condition. Only the master can generate the start and stop conditions.

Start Condition

A start condition is defined as a HIGH-to-LOW transition on SDATA while SCLK is HIGH. At the end of a transfer, the master can generate a start condition without previously generating a stop condition; this is known as a "repeated start" or "restart" condition.

Stop Condition

A stop condition is defined as a LOW-to-HIGH transition on SDATA while SCLK is HIGH.

Data Transfer

Data is transferred serially, 8 bits at a time, with the MSB transmitted first. Each byte of data is followed by an acknowledge bit or a no-acknowledge bit. This data transfer mechanism is used for the slave address/data direction byte and for message bytes.

One data bit is transferred during each SCLK clock period. SDATA can change when SCLK is LOW and must be stable while SCLK is HIGH.



Slave Address/Data Direction Byte

Bits [7:1] of this byte represent the device slave address and bit [0] indicates the data transfer direction. A "0" in bit [0] indicates a WRITE, and a "1" indicates a READ. The default slave addresses used by the AR0132AT are 0x20(write address) and0x21 (read address) in accordance with the specification. Alternate slave addresses of 0x30 (write address) and 0x31 (read address) can be selected by enabling and asserting the SADDR input.

An alternate slave address can also be programmed through R0x31FC.

Message Byte

Message bytes are used for sending register addresses and register write data to the slave device and for retrieving register read data.

Acknowledge Bit

Each 8-bit data transfer is followed by an acknowledge bit or a no-acknowledge bit in the SCLK clock period following the data transfer. The transmitter (which is the master when writing, or the slave when reading) releases SDATA. The receiver indicates an acknowledge bit by driving SDATA LOW. As for data transfers, SDATA can change when SCLK is LOW and must be stable while SCLK is HIGH.

No-Acknowledge Bit

The no-acknowledge bit is generated when the receiver does not drive SDATA LOW during the SCLK clock period following a data transfer. A no-acknowledge bit is used to terminate a read sequence.

Typical Sequence

A typical READ or WRITE sequence begins by the master generating a start condition on the bus. After the start condition, the master sends the 8-bit slave address/data direction byte. The last bit indicates whether the request is for a read or a write, where a "0" indicates a write and a "1" indicates a read. If the address matches the address of the slave device, the slave device acknowledges receipt of the address by generating an acknowledge bit on the bus.

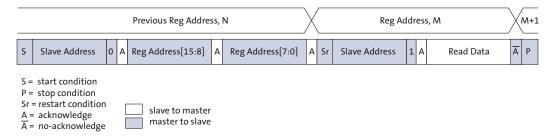
If the request was a WRITE, the master then transfers the 16-bit register address to which the WRITE should take place. This transfer takes place as two 8-bit sequences and the slave sends an acknowledge bit after each sequence to indicate that the byte has been received. The master then transfers the data as an 8-bit sequence; the slave sends an acknowledge bit at the end of the sequence. The master stops writing by generating a (re)start or stop condition.

If the request was a READ, the master sends the 8-bit write slave address/data direction byte and 16-bit register address, the same way as with a WRITE request. The master then generates a (re)start condition and the 8-bit read slave address/data direction byte, and clocks out the register data, eight bits at a time. The master generates an acknowledge bit after each 8-bit transfer. The slave's internal register address is automatically incremented after every 8 bits are transferred. The data transfer is stopped when the master sends a no-acknowledge bit.

Single READ from Random Location

This sequence (Figure 24) starts with a dummy WRITE to the 16-bit address that is to be used for the READ. The master terminates the WRITE by generating a restart condition. The master then sends the 8-bit read slave address/data direction byte and clocks out one byte of register data. The master terminates the READ by generating a no-acknowledge bit followed by a stop condition. Figure 24 shows how the internal register address maintained by the AR0132AT is loaded and incremented as the sequence proceeds.

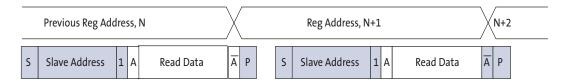
Figure 24: Single READ from Random Location



Single READ from Current Location

This sequence (Figure 25) performs a read using the current value of the AR0132AT internal register address. The master terminates the READ by generating a no-acknowledge bit followed by a stop condition. The figure shows two independent READ sequences.

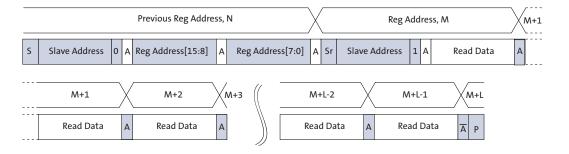
Figure 25: Single READ from Current Location



Sequential READ, Start from Random Location

This sequence (Figure 26) starts in the same way as the single READ from random location (Figure 24). Instead of generating a no-acknowledge bit after the first byte of data has been transferred, the master generates an acknowledge bit and continues to perform byte READs until "L" bytes have been read.

Figure 26: Sequential READ, Start from Random Location



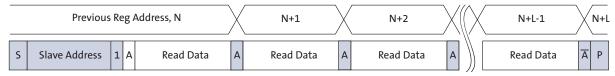
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Sequential READ, Start from Current Location

This sequence (Figure 27) starts in the same way as the single READ from current location (Figure 25). Instead of generating a no-acknowledge bit after the first byte of data has been transferred, the master generates an acknowledge bit and continues to perform byte READs until "L" bytes have been read.

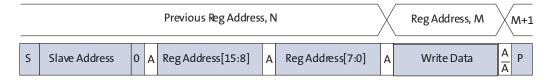
Figure 27: Sequential READ, Start from Current Location



Single WRITE to Random Location

This sequence (Figure 28) begins with the master generating a start condition. The slave address/data direction byte signals a WRITE and is followed by the HIGH then LOW bytes of the register address that is to be written. The master follows this with the byte of write data. The WRITE is terminated by the master generating a stop condition.

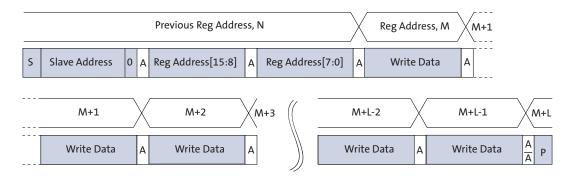
Figure 28: Single WRITE to Random Location



Sequential WRITE, Start at Random Location

This sequence (Figure 29) starts in the same way as the single WRITE to random location (Figure 28). Instead of generating a no-acknowledge bit after the first byte of data has been transferred, the master generates an acknowledge bit and continues to perform byte WRITEs until "L" bytes have been written. The WRITE is terminated by the master generating a stop condition.

Figure 29: Sequential WRITE, Start at Random Location



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Spectral Characteristics

Figure 30: Quantum Efficiency – Color Sensor

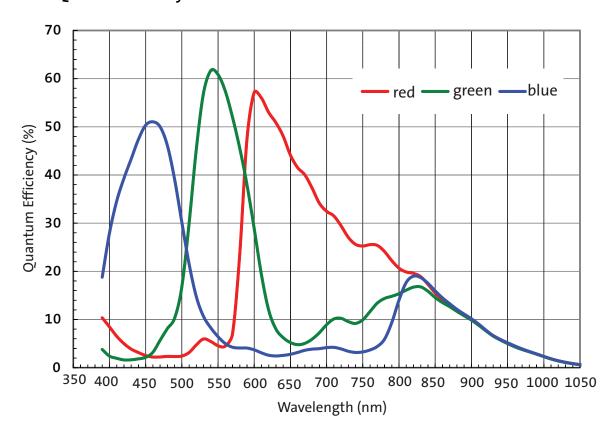
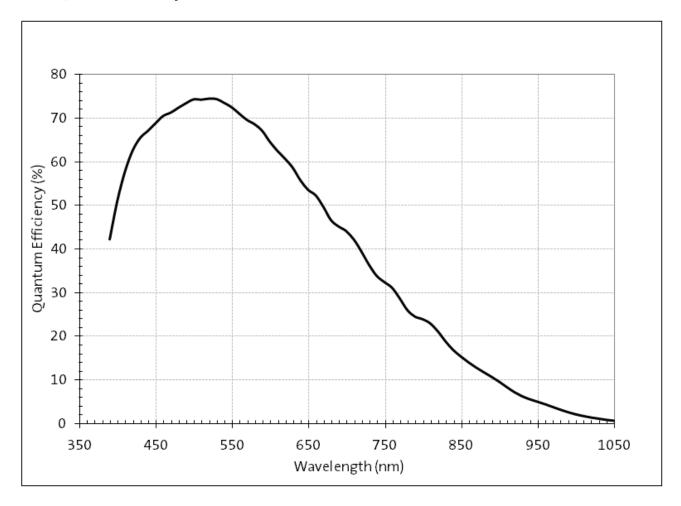


Figure 31: Quantum Efficiency – Monochrome Sensor



Electrical Specifications

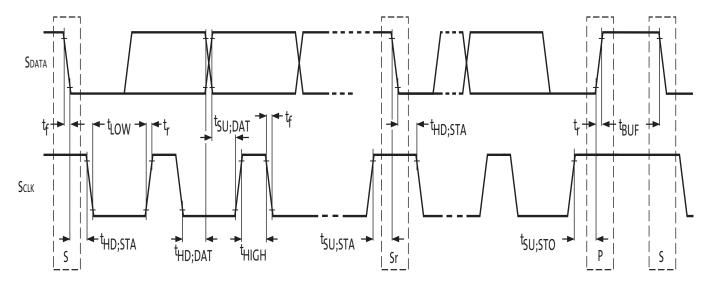
Unless otherwise stated, the following specifications apply to the following conditions:

 $\label{eq:VDD} VDD=1.8V-0.10/+0.15; VDD_IO=VDD_PLL=VAA=VAA_PIX=2.8V\pm0.3V; VDD_SLVS=0.4V-0.1/+0.2; T_A=-30^{\circ}C \ to \ +70^{\circ}C; \ output \ load=10pF; frequency=74.25 \ MHz; HiSPi \ off.$

Two-Wire Serial Register Interface

The electrical characteristics of the two-wire serial register interface (SCLK, SDATA) are shown in Figure 32 and Table 11.

Figure 32: Two-Wire Serial Bus Timing Parameters



Note: Read sequence: For an 8-bit READ, read waveforms start after WRITE command and register address are issued.

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Table 11: Two-Wire Serial Bus Characteristics

 f_{EXTCLK} = 27 MHz; VDD = 1.8V; VDD_IO = 2.8V; VAA = 2.8V; VAA_PIX = 2.8V; VDD_PLL = 2.8V; T_A = 25°C

		Standard-I	Mode	Fast-Mo	ode	
Parameter	Symbol	Min	Max	Min	Max	Unit
SCLK Clock Frequency	^f SCL	0	100	0	400	KHz
SCLK High		8*EXTCLK+ Sclк rise time		8*EXTCLK+ EXTCLK rise time		μs
SCLK LOW		6*EXTCLK+ Sclк rise time		6*EXTCLK+ SCLK rise time		μs
Hold time (repeated) START condition						
After this period, the first clock pulse is generated	^t HD;STA	4.0	-	0.6	-	μs
LOW period of the SCLK clock	^t LOW	4.7	-	1.3	-	μs
HIGH period of the SCLK clock	^t HIGH	4.0	-	0.6	-	μs
Set-up time for a repeated START condition	^t SU;STA	4.7	-	0.6	-	μs
Data hold time:	^t HD;DAT	04	3.45 ⁵	0 ⁶	0.9 ⁵	μs
Data set-up time	^t SU;DAT	250	-	100 ⁶	-	ns
Rise time of both SDATA and SCLK signals	^t r	-	1000	20 + 0.1Cb ⁷	300	ns
Fall time of both SDATA and SCLK signals	^t f	-	300	20 + 0.1Cb ⁷	300	ns
Set-up time for STOP condition	^t SU;STO	4.0	-	0.6	-	μs
Bus free time between a STOP and START condition	^t BUF	4.7	-	1.3	-	μs
Capacitive load for each bus line	Cb	-	400	-	400	pF
Serial interface input pin capacitance	CIN_SI	=	3.3	-	3.3	pF
SDATA max load capacitance	CLOAD_SD	-	30	-	30	pF
SDATA pull-up resistor	RSD	1.5	4.7	1.5	4.7	ΚΩ

Notes

- 1. This table is based on I²C standard (v2.1 January 2000). Philips Semiconductor.
- 2. Two-wire control is I^2 C-compatible.
- 3. All values referred to V_{IHmin} = 0.9 VDD and V_{ILmax} = 0.1 VDD levels. Sensor EXCLK = 27 MHz.
- 4. A device must internally provide a hold time of at least 300 ns for the SDATA signal to bridge the undefined region of the falling edge of SCLK.
- 5. The maximum t_{HD;DAT} has only to be met if the device does not stretch the LOW period (t_{LOW}) of the SCLK signal.
- 6. A Fast-mode I²C-bus device can be used in a Standard-mode I²C-bus system, but the requirement $t_{SU;DAT}$ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCLK signal. If such a device does stretch the LOW period of the SCLK signal, it must output the next data bit to the SDATA line t_R max + $t_{SU;DAT}$ = 1000 + 250 = 1250 ns (according to the Standard-mode I²C-bus specification) before the SCLK line is released.
- 7. Cb = total capacitance of one bus line in pF.

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I/O Timing

By default, the AR0132AT launches pixel data, FV, and LV with the falling edge of PIXCLK. The expectation is that the user captures DOUT[11:0], FV, and LV using the rising edge of PIXCLK. This can be changed using register R0x3028.

See Figure 33 and Table 12 for I/O timing (AC) characteristics.

Figure 33: I/O Timing Diagram

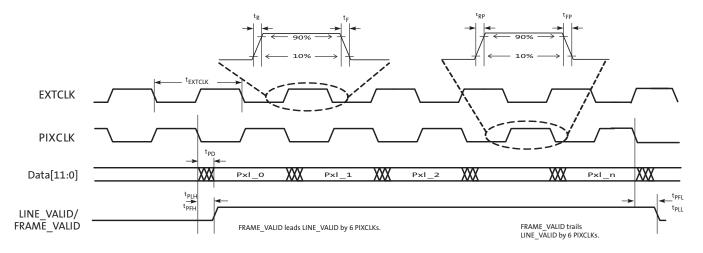


Table 12: I/O Timing Characteristics (2.8V VDD_IO)¹
Conditions: f_{PIXCLK} = 74.25 MHz (720P 60fps) VDD_IO = 2.8V;

Slew rate setting = 6 for PIXCLK; Slew rate setting = 7 for parallel ports

Symbol	Definition	Condition	Min	Тур	Max	Unit
f _{EXTCLK}	Input clock frequency		6	_	50	MHz
t _{EXTCLK}	Input clock period		20	_	166	ns
t _R	Input clock rise time		_	3	_	ns
^t F	Input clock fall time		_	3	_	ns
t _{JITTER}	Input clock jitter		_	_	600	ps
t _{CP}	EXTCLK to PIXCLK propagation delay	Nominal voltages, PLL Disabled, PCLK slew rate=4	5.5	_	13.7	ns
t _{RP}	Pixclk rise time	PCLK slew rate = 6	1.2	_	2.9	ns
t _{FP}	Pixclk fall time	PCLK slew rate = 6	1.2	_	2.9	ns
	Pixclk duty cycle		45	50	55	%
f _{PIXCLK}	PIXCLK frequency ²		6	_	74.25	MHz
t _{PD}	PIXCLK to data valid	PCLK slew rate = 6, Parallel slew rate = 7	-2	_	2.5	ns
t _{PFH}	PIXCLK to FV HIGH	PCLK slew rate = 6, Parallel slew rate = 7	-2	_	2.5	ns
t _{PLH}	PIXCLK to LV HIGH	PCLK slew rate = 6, Parallel slew rate = 7	-2	_	2.5	ns
t _{PFL}	PIXCLK to FV LOW	PCLK slew rate = 6, Parallel slew rate = 7	-2	_	2.5	ns
t _{PLL}	PIXCLK to LV LOW	PCLK slew rate = 6, Parallel slew rate = 7	-2	_	2.5	ns



Notes:

- 1. Minimum and maximum values are taken at the temperature and voltage limits; for instance, 105°C at 2.5V, and -40°C at 3.1V. All values are taken at the 50% transition point. The loading used is 10pF.
- 2. Jitter from PIXCLK is already taken into account as the data of all the output parameters.
- 3. Input clock pad delay is not included in the total delay numbers for t_{CP} .

Table 13: I/O Timing Characteristics (1.8V VDD_IO)¹

Conditions: f_{PIXCLK} = 74.25 MHz (720P 60fps) VDD_IO = 1.8V; Slew rate setting = 6 for PIXCLK; Slew rate setting = 7 for parallel ports

Symbol	Definition	Condition	Min	Тур	Max	Unit
f _{EXTCLK}	Input clock frequency		6	-	50	MHz
t _{EXTCLK}	Input clock period		20	-	166	ns
t _R	Input clock rise time		-	3	-	ns
t _F	Input clock fall time		-	3	-	ns
tJITTER	Input clock jitter		_	_	600	ps
t _{CP}	EXTCLK to PIXCLK propagation delay	Nominal voltages, PLL Disabled, PCLK slew rate=4	6.2	_	15.3	ns
t _{RP}	Pixel rise time	PCLK slew rate = 6	1.8	-	4.8	ns
t _{FP}	Pixel fall time	PCLK slew rate = 6	1.7	-	4.5	ns
	Pixel duty cycle		45	50	55	%
f _{PIXCLK}	PIXCLK frequency ²		6		74.25	MHz
t _{PD}	PIXCLK to data valid	PCLK slew rate = 6, Parallel slew rate = 7	-2.5	-	2	ns
t _{PFH}	PIXCLK to FV HIGH	PCLK slew rate = 6, Parallel slew rate = 7	-2.5	-	2	ns
t _{PLH}	PIXCLK to LV HIGH	PCLK slew rate = 6, Parallel slew rate = 7	-2.5	-	2	ns
t _{PFL}	PIXCLK to FV LOW	PCLK slew rate = 6, Parallel slew rate = 7	-2.5	_	2	ns
t _{PLL}	PIXCLK to LV LOW	PCLK slew rate = 6, Parallel slew rate = 7	-2.5	-	2	ns

Notes:

- 1. Minimum and maximum values are taken at the temperature and voltage limits; for instance, 105°C TA at 1.7V, and -40°C TA at 1.95V. All values are taken at the 50% transition point. The loading used is 10pF.
- 2. Jitter from PIXCLK is already taken into account as the data of all the output parameters.
- 3. Input clock pad delay is not included in the total delay numbers for t_{CP}

Table 14: I/O Rise Slew Rate (2.8V VDD_IO)¹

Parallel Slew Rate (R0x306E[15:13])	Conditions	Min	Тур	Max	Units
7	Default	1.08	1.77	2.72	V/ns
6	Default	0.77	1.26	1.94	V/ns
5	Default	0.58	0.95	1.46	V/ns
4	Default	0.44	0.70	1.08	V/ns
3	Default	0.32	0.51	0.78	V/ns
2	Default	0.23	0.37	0.56	V/ns
1	Default	0.16	0.25	0.38	V/ns
0	Default	0.10	0.15	0.22	V/ns

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Notes: 1. Minimum and maximum values are taken at the temperature and voltage limits; for instance, 105°C TA at 2.5V, and -40°C TA at 3.1V. The loading used is 20pF.

Table 15: I/O Fall Slew Rate (2.8V VDD_IO)¹

Parallel Slew Rate (R0x306E[15:13])	Conditions	Min	Тур	Max	Units
7	Default	1.00	1.62	2.41	V/ns
6	Default	0.76	1.24	1.88	V/ns
5	Default	0.60	0.98	1.50	V/ns
4	Default	0.46	0.75	1.16	V/ns
3	Default	0.35	0.56	0.86	V/ns
2	Default	0.25	0.40	0.61	V/ns
1	Default	0.17	0.27	0.41	V/ns
0	Default	0.11	0.16	0.24	V/ns

Notes: 1. Minimum and maximum values are taken at the temperature and voltage limits; for instance, 105°C TA at 2.5V, and -40°C TA at 3.1V. The loading used is 20pF.

Table 16: I/O Rise Slew Rate (1.8V VDD_IO)¹

Parallel Slew Rate (R0x306E[15:13])	Conditions	Min	Тур	Max	Units
7	Default	0.41	0.65	1.10	V/ns
6	Default	0.30	0.47	0.79	V/ns
5	Default	0.24	0.37	0.61	V/ns
4	Default	0.19	0.28	0.46	V/ns
3	Default	0.14	0.21	0.34	V/ns
2	Default	0.10	0.15	0.24	V/ns
1	Default	0.07	0.10	0.16	V/ns
0	Default	0.04	0.06	0.10	V/ns

Notes: 1. Minimum and maximum values are taken at the temperature and voltage limits; for instance, 105°C TA at 1.7V, and -40°C TA at 1.95V. The loading used is 20pF.

Table 17: I/O Fall Slew Rate (1.8V VDD_IO)¹

Parallel Slew Rate (R0x306E[15:13])	Conditions	Min	Тур	Max	Units
7	Default	0.42	0.68	1.11	V/ns
6	Default	0.32	0.51	0.84	V/ns
5	Default	0.26	0.41	0.67	V/ns
4	Default	0.20	0.32	0.52	V/ns
3	Default	0.16	0.24	0.39	V/ns
2	Default	0.12	0.18	0.28	V/ns
1	Default	0.08	0.12	0.19	V/ns
0	Default	0.05	0.07	0.11	V/ns

Notes: 1. Minimum and maximum values are taken at the temperature and voltage limits; for instance, 105°C TA at 1.7V, and -40°C TA at 1.95V. The loading used is 20pF.



DC Electrical Characteristics

The DC electrical characteristics are shown in the tables below.

Table 18: DC Electrical Characteristics

Symbol	Definition	Condition	Min	Тур	Max	Unit
VDD	Core digital voltage		1.7	1.8	1.95	V
VDD_IO	I/O digital voltage		1.7/2.5	1.8/2.8	1.9/3.1	V
VAA	Analog voltage		2.5	2.8	3.1	V
VAA_PIX	Pixel supply voltage		2.5	2.8	3.1	V
VDD_PLL	PLL supply voltage		2.5	2.8	3.1	V
VDD_SLVS	HiSPi supply voltage for SLVS mode		0.3	0.4	0.6	V
VDD_SLVS	HiSPi supply voltage for HiVCM mode		1.7	1.8	1.95	V
VIH	Input HIGH voltage		VDD_IO*0.7	-	_	V
VIL	Input LOW voltage		_	-	VDD_IO*0.3	V
lin	Input leakage current	No pull-up resistor; Vin = VDD_IO or DGND	-	_	20	μΑ
Vон	Output HIGH voltage		VDD_IO-0.3	-	_	V
Vol	Output LOW voltage		_	_	0.4	V
Іон	Output HIGH current	At specified Voн	-22	_	_	mA
IOL	Output LOW current	At specified Vol	_	_	22	mA

Note: $T_A = -40 \,^{\circ}\text{C}$ to 105 $^{\circ}\text{C}$

Caution

Stresses greater than those listed in Table 19 may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Table 19: Absolute Maximum Ratings

Symbol	Parameter	Minimum	Maximum	Unit	Symbol
VSUPPLY	Power supply voltage (all supplies)	-0.3	4.3	V	VSUPPLY
ISUPPLY	Total power supply current	_	200	mA	ISUPPLY
IGND	Total ground current	_	200	mA	IGND
VIN	DC input voltage	-0.3	VDD_IO + 0.3	V	VIN
Vout	DC output voltage	-0.3	VDD_IO + 0.3	V	Vout
Tstg ¹	Storage temperature	-40	+150	°C	TsTG ¹

Notes:

- 1. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- 2. To keep dark current and shot noise artifacts from impacting image quality, keep operating temperature at a minimum.
- 3. $TA = -40 \degree C \text{ to } 105 \degree C$

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Table 20: Operating Current Consumption in Parallel Output and Linear Mode

Definition	Condition	Symbol	Min	Тур	Max	Unit
Digital operating current	Streaming, 1280x960 45fps	IDD1	_	63	90	mA
I/O digital operating current	Streaming, 1280x960 45fps	IDD_IO	_	35	40	mA
Analog operating current	Streaming, 1280x960 45fps	IAA	_	30	45	mA
Pixel supply current	Streaming, 1280x960 45fps	IAA_PIX	_	10	15	mA
PLL supply current	Streaming, 1280x960 45fps	IDD_PLL	_	7	15	mA
Digital operating current	Streaming, 720p 60 fps	IDD1	_	63	90	mA
I/O digital operating current	Streaming, 720p 60 fps	IDD_IO	_	35	40	mA
Analog operating current	Streaming, 720p 60 fps	IAA	_	30	45	mA
Pixel supply current	Streaming, 720p 60 fps	IAA_PIX	_	10	15	mA
PLL supply current	Streaming, 720p 60f ps	IDD_PLL	_	7	15	mA

1. Operating currents are measured at the following conditions:

VAA = VAA_PIX = VDD_IO = VDD_PLL = 2.8V

VDD =1.8V

PLL Enabled and PIXCLK = 74.25 MHz

 $T_A = 25^{\circ}C$

CLOAD = 10pF Measured in dark

Table 21: Operating Current Consumption in Parallel Output and HDR Mode

Definition	Condition	Symbol	Min	Тур	Max	Unit
Digital operating current	Streaming, 1280x960 45fps	IDD	_	95	115	mA
I/O digital operating current	Streaming, 1280x960 45fps	IDD_IO	_	35	40	mA
Analog operating current	Streaming, 1280x960 45fps	IAA	_	65	75	mA
Pixel supply current	Streaming, 1280x960 45fps	IAA_PIX	_	15	20	mA
PLL supply current	Streaming, 1280x960 45fps	IDD_PLL	_	7	15	mA
Digital operating current	Streaming, 720p 60 fps	IDD	_	95	115	mA
I/O digital operating current	Streaming, 720p 60 fps	IDD_IO	_	35	40	mA
Analog operating current	Streaming, 720p 60 fps	IAA	_	61	75	mA
Pixel supply current	Streaming, 720p 60 fps	IAA_PIX	_	15	20	mA
PLL supply current	Streaming, 720p 60 fps	IDD_PLL	_	7	15	mA

Notes: 1. Operating currents are measured at the following conditions:

VAA = VAA_PIX = VDD_IO = VDD_PLL = 2.8V

VDD = 1.8V

PLL Enabled and PIXCLK = 74.25 MHz

 $T_A = 25$ °C

CLOAD = 10pF Measured in dark



Table 22: Operating Currents in HiSPi Output and Linear Mode

Definition	Condition	Symbol	Min	Тур	Max	Unit
Digital Operating Current	Streaming 1280x960 45fps	IDD	_	95	115	mA
I/O digital operating current	Streaming 1280x960 45fps	IDD_IO	_	100	150	μΑ
Analog operating current	Streaming 1280x960 45fps	IAA	_	30	45	mA
Pixel Supply Current	Streaming 1280x960 45fps	IAA_PIX	_	10	15	mA
PLL Supply Current	Streaming 1280x960 45fps	IDD_PLL	_	7	15	mA
SLVS Supply Current	Current LoVCM Mode Streaming 1280x960 45fps	IDD_SLVS	-	8	15	mA
	Current HiVCM Mode Streaming 1280x960 45fps		_	16	25	mA
Digital Operating Current	Streaming 720p 60 fps	IDD	_	95	115	mA
I/O digital operating current	Streaming 720p 60 fps	IDD_IO	_	100	150	μΑ
Analog operating current	Streaming 720p 60 fps	IAA	-	30	45	mA
Pixel Supply Current	Streaming 720p 60 fps	IAA_PIX	_	10	15	mA
PLL Supply Current	Streaming 720p 60 fps	IDD_PLL	_	7	15	mA
SLVS Supply Current	Current LoVCM Mode Streaming 720p 60 fps	IDD_SLVS	-	8	15	mA
	Current HiVCM Mode Streaming 1280x960 60fps		-	16	25	mA

Notes: 1. Operating currents are measured at the following conditions:

 $VAA = VAA_PIX = VDD_IO = VDD_PLL = 2.8V$

 $VDD = 1.8\overline{V}$

VDD_SLVS = 0.4V (LoVCM) VDD_SLVS = 1.8V (HiVCM)

PLL Enabled and PIXCLK = 74.25 MHz

 $T_A = 25^{\circ}C$

CLOAD = 10pF Measured in dark



Table 23: Operating Current in HiSPi Output and HDR Mode

Definition	Condition	Symbol	Min	Тур	Max	Unit
Digital Operating Current	Streaming 1280x960 45 fps	IDD	_	115	130	mA
I/O digital operating current	Streaming 1280x960 45 fps	IDD_IO	_	100	150	μΑ
Analog operating current	Streaming 1280x960 45 fps	IAA	_	65	75	mA
Pixel Supply Current	Streaming 1280x960 45 fps	IAA_PIX	_	15	20	mA
PLL Supply Current	Streaming 1280x960 45 fps	IDD_PLL	_	7	15	mA
SLVS Supply Current	Current LoVCM Mode Streaming 1280x960 45 fps	IDD_SLVS	-	8	15	mA
	Current HiVCM Mode Streaming 1280x960 45 fps		-	16	25	mA
Digital Operating Current	Streaming 720p 60 fps	IDD	_	115	130	mA
I/O digital operating current	Streaming 720p 60 fps	IDD_IO	_	100	150	μΑ
Analog operating current	Streaming 720p 60 fps	IAA	_	65	75	mA
Pixel Supply Current	Streaming 720p 60 fps	IAA_PIX	_	15	20	mA
PLL Supply Current	Streaming 720p 60 fps	IDD_PLL	_	7	15	mA
SLVS Supply Current	Current LoVCM Mode Streaming 720p 60 fps	IDD_SLVS	-	8	15	mA
	Current HiVCM Mode Streaming 1280x960 60fps		_	16	25	mA

Notes:

1. Operating currents are measured at the following conditions:

VAA=VAA PIX=VDD IO=VDD PLL=2.8V

VDD=1.8V

VDD_SLVS = 0.4V (LoVCM) VDD_SLVS = 1.8V (HiVCM)

PLL Enabled and PIXCLK=74.25MHz

 $T_A = 25^{\circ}C$

CLOAD = 10pF Measured in dark

Table 24: Standby Current Consumption

Definition	Condition	Symbol	Min	Тур	Max	Unit
Hard standby (clock off)	Analog, 2.8V	_	_	30	100	ìΑ
	Digital, 1.8V	_	_	85	2500	ì A
Hard standby (clock on)	Analog, 2.8V	_	_	30	100	ìΑ
	Digital, 1.8V	_	_	1.55	4	mA
Soft standby (clock off)	Analog, 2.8V	_	_	85	100	ìΑ
	Digital, 1.8V	_	_	85	2500	ìΑ
Soft standby (clock on)	Analog, 2.8V	_	_	30	100	ìΑ
	Digital, 1.8V	-	-	1.55	4	mA

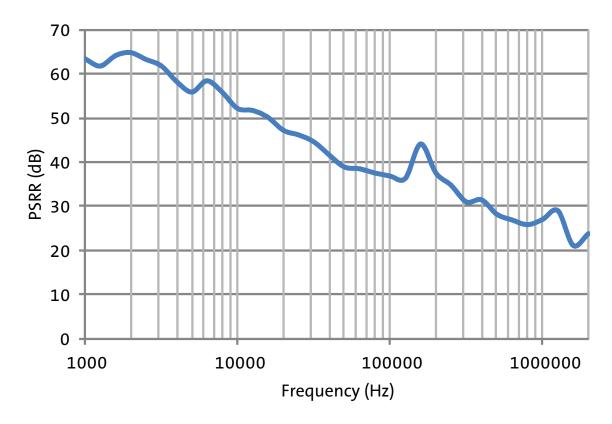
Notes:

- 1. Analog VAA + VAA_PIX + VDD_PLL
- 2. $Digital VDD + VDD_IO + VDD_SLVS$

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Figure 34: Power Supply Rejection Ratio



HiSPi Electrical Specifications

The ON Semiconductor AR0132AT sensor supports both SLVS and HiVCM HiSPi modes. Please refer to the High-Speed Serial Pixel (HiSPi) Interface Physical Layer Specification v2.00.00 for electrical definitions, specifications, and timing information. The VDD_SLVS supply in this datasheet corresponds to VDD_TX in the HiSPi Physical Layer Specification. Similarly, VDD is equivalent to VDD_HiSPi as referenced in the specification.

Power-On Reset and Standby Timing

Power-Up Sequence

The recommended power-up sequence for the AR0132AT is shown in Figure 35. The available power supplies (VDD_IO, VDD, VDD_SLVS, VDD_PLL, VAA, VAA_PIX) must have the separation specified below.

- 1. Turn on VDD_PLL power supply.
- 2. After 0–10 μ s, turn on VAA and VAA_PIX power supply.
- 3. After 0–10µs, turn on VDD_IO power supply.
- 4. After the last power supply is stable, enable EXTCLK.
- 5. Assert RESET_BAR for at least 1ms.
- 6. Wait 850000 EXTCLKs (for internal initialization into software standby).
- 7. Configure PLL, output, and image settings to desired values.
- 8. Wait 1ms for the PLL to lock.
- 9. Set streaming mode (R0x301A[2] = 1).

Figure 35: Power Up

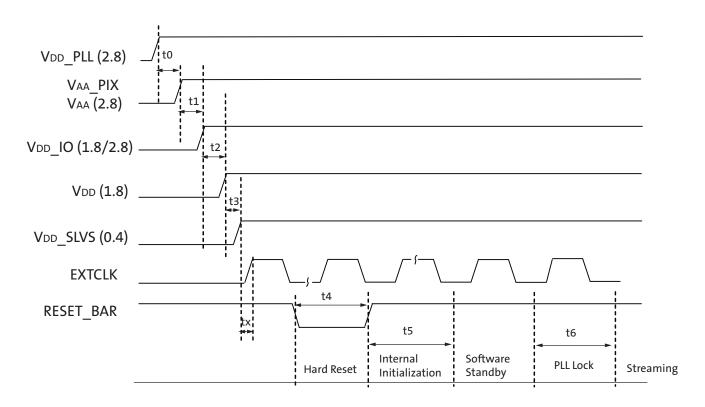


Table 25: Power-Up Sequence

Definition	Symbol	Minimum	Typical	Maximum	Unit
VDD_PLL to VAA/VAA_PIX ³	t0	0	10	-	μς
VAA/VAA_PIX to VDD_IO	t1	0	10	-	μs
VDD_IO to VDD	t2	0	10	-	μs
VDD to VDD_SLVS	t3	0	10	_	μς
Xtal settle time	tx	_	30 ¹	-	ms
Hard Reset	t4	1 ²	_	-	ms
Internal Initialization	t5	850000	_	_	EXTCLKs
PLL Lock Time	t6	1	_	_	ms

Notes:

- 1. Xtal settling time is component-dependent, usually taking about 10 100 ms.
- 2. Hard reset time is the minimum time required after power rails are settled. In a circuit where Hard reset is held down by RC circuit, then the RC time must include the all power rail settle time and Xtal settle time.
- 3. It is critical that VDD_PLL is not powered up after the other power supplies. It must be powered before or at least at the same time as the others. If the case happens that VDD_PLL is powered after other supplies then the sensor may have functionality issues and will experience high current draw on this supply.
- 4. TA = -40 °C to 105 °C

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Power-Down Sequence

The recommended power-down sequence for the AR0132AT is shown in Figure 36. The available power supplies (VDD_IO, VDD, VDD_SLVS, VDD_PLL, VAA, VAA_PIX) must have the separation specified below. Power may be removed from all supplies simultaneously, and a sudden loss of power on all rails does not cause damage or affect the lifetime of the device.

- 1. Disable streaming if output is active by setting standby R0x301A[2] = 0
- 2. The soft standby state is reached after the current row or frame, depending on configuration, has ended.
- 3. Turn off VDD_SLVS.
- 4. Turn off VDD.
- 5. Turn off VDD_IO
- 6. Turn off VAA/VAA_PIX.
- 7. Turn off VDD_PLL.

Figure 36: Power Down

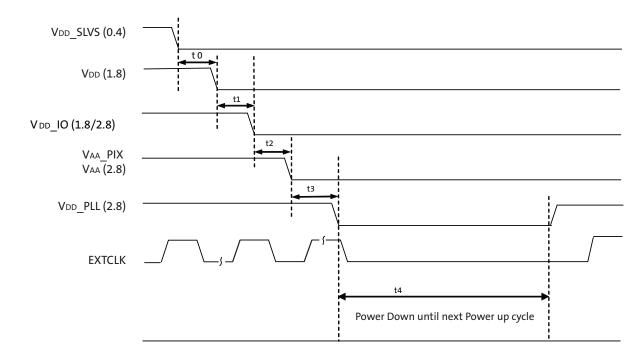


Table 26: Power-Down Sequence

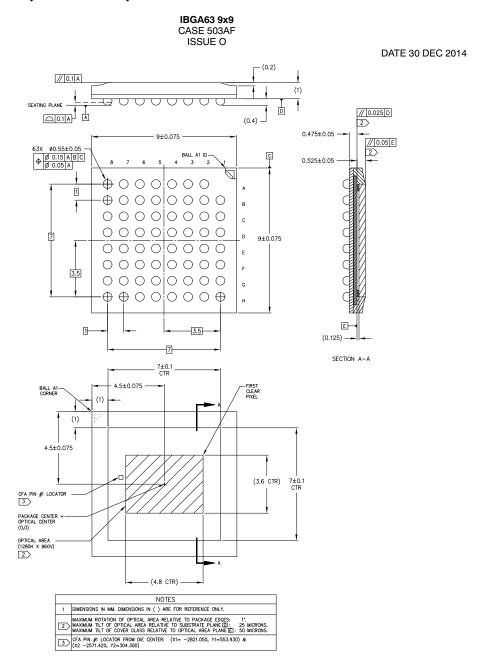
Definition	Symbol	Minimum	Typical	Maximum	Unit
VDD_SLVS to VDD	t0	0	_	_	μs
VDD to VDD_IO	t1	0	_	_	μs
VDD_IO to VAA/VAA_PIX	t2	0	_	_	μs
VAA/VAA_PIX to VDD_PLL	t3	0	_	_	μs
PwrDn until Next PwrUp Time	t4	100	1	_	ms

Notes: 1. t4 is required between power down and next power up time; all decoupling caps from regulators must be completely discharged.

2. Ta = -40 °C to 105 °C



Package Dimensions (Case 503AF)





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